



# **X-ray detectors**

## **How do they work ?**

## **How are they characterized ?**

**Heinz Graafsma**

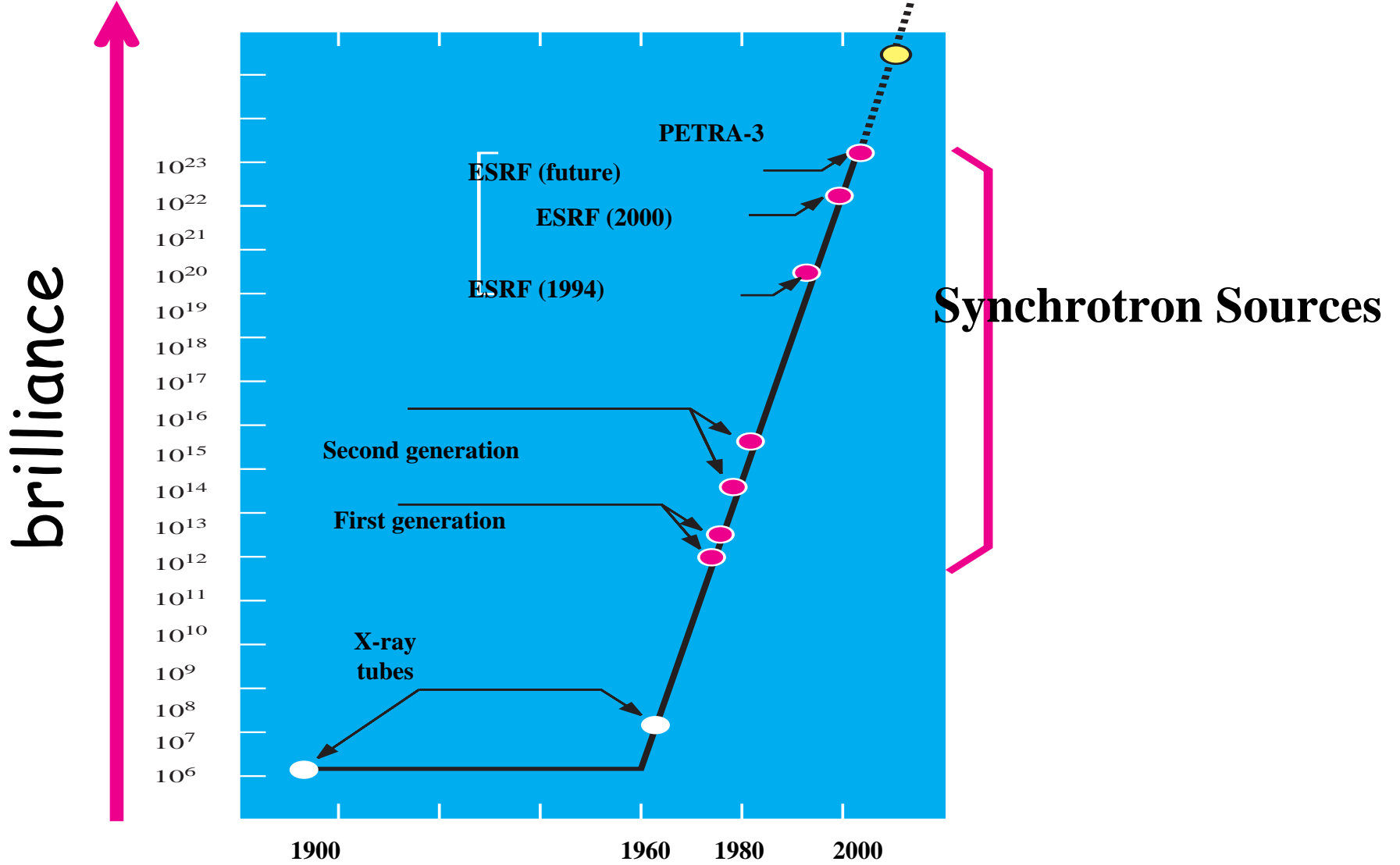
Photon Science Detector Group

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heinz.graafsma@desy.de

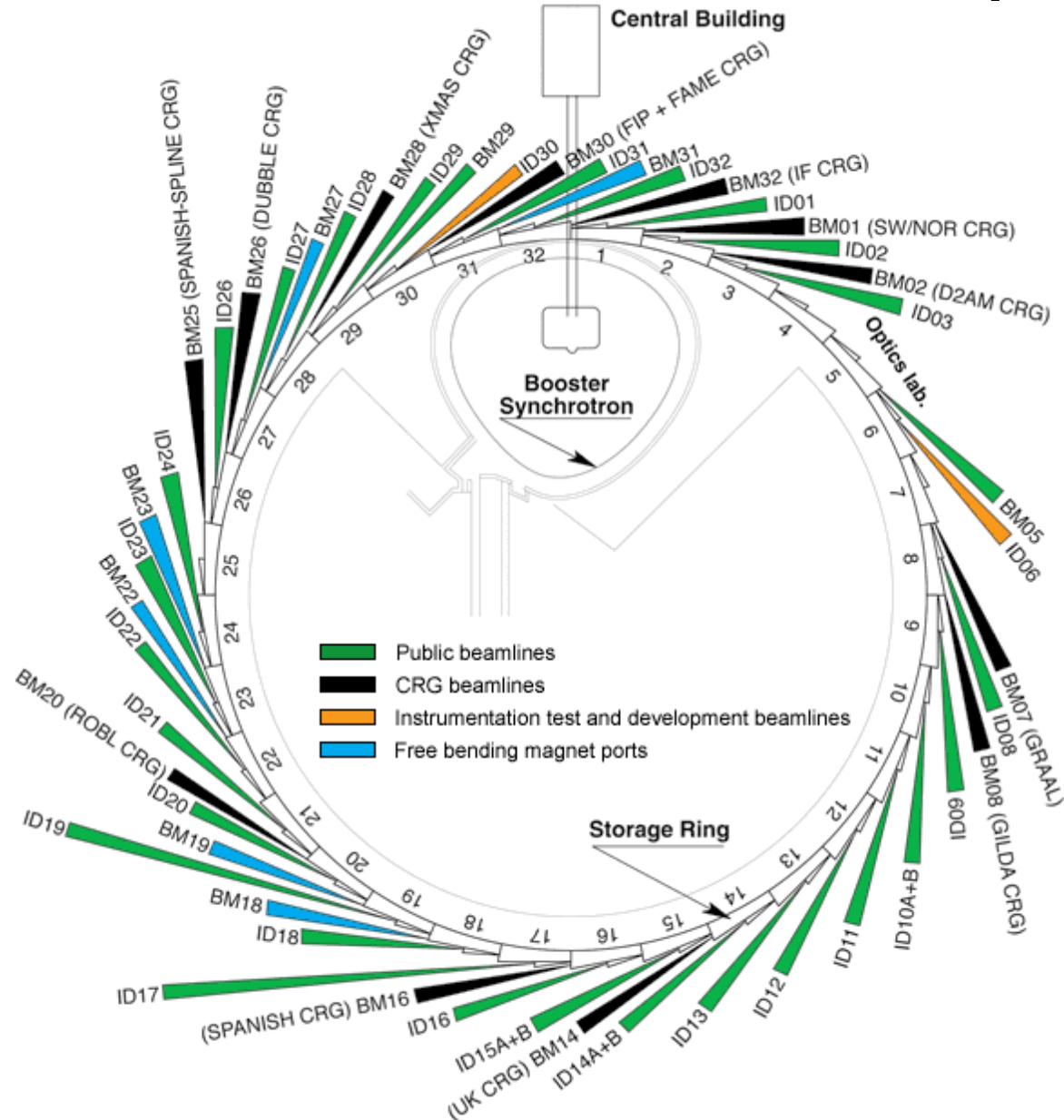


# The Detector Challenge:





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- **Spectroscopy** (determine energy of the X-rays):
  - meV – 1 keV resolution
  - time resolved (100 psec) – static
- **Imaging** (determine intensity distribution)
  - Micro-meter – millimeter resolution
  - Tomographic
  - Time resolved
- **Scattering** (determine intensity as function momentum transfer = angle)
  - Small angle – protein crystallography
  - Diffuse – Bragg
  - Crystals - liquids



# What are the basic principles ?

1. X-ray light is quantized (photons)
2. In order to detect you have to transfer energy from the particle to the detector
3. A photon is either fully absorbed or not at all (no track like for MIPs)
4. The energy absorbed is transferred into an electrical signal and then into a number (digitized).



# Signal Generation → Needs transfer of Energy

Any form of elementary excitation can be used to detect the radiation signal:

Ionization (gas, liquids, solids)

Excitation of optical states (scintillators)

Excitation of lattice vibrations (phonons)

Breakup of Cooper pairs in superconductors

Typical excitation energies:

Ionization in semiconductors: 1 - 5 eV

Scintillation: appr. 20 eV

Phonons: meV

Breakup of Cooper pairs: meV



What would you like to know about your X-rays?

1. Intensity or flux (photons/sec)
2. Energy (wavelength)
3. Position (or mostly angles)
4. Arrival time (time resolved experiments)
5. Polarization



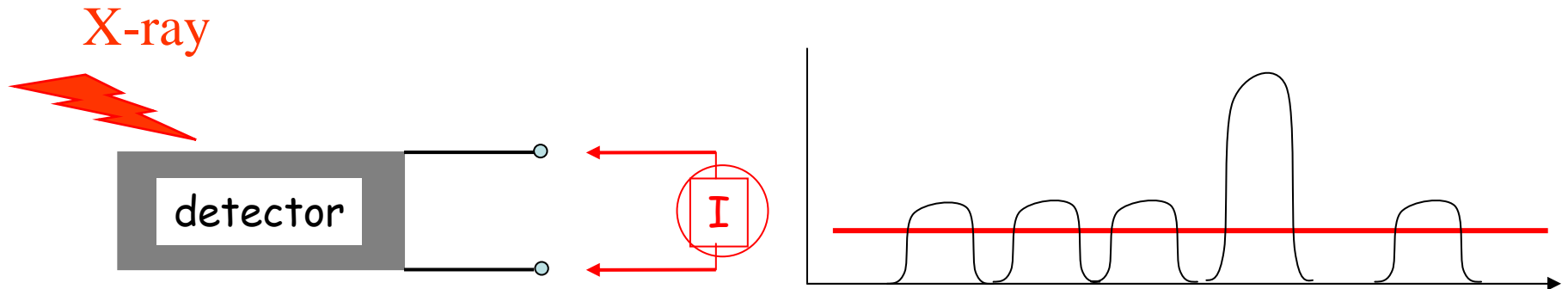
# 3 modes of detection

1. Current (=flux) mode operation
2. Integration mode operation
3. Photon counting mode operation
4. Energy dispersive mode operation

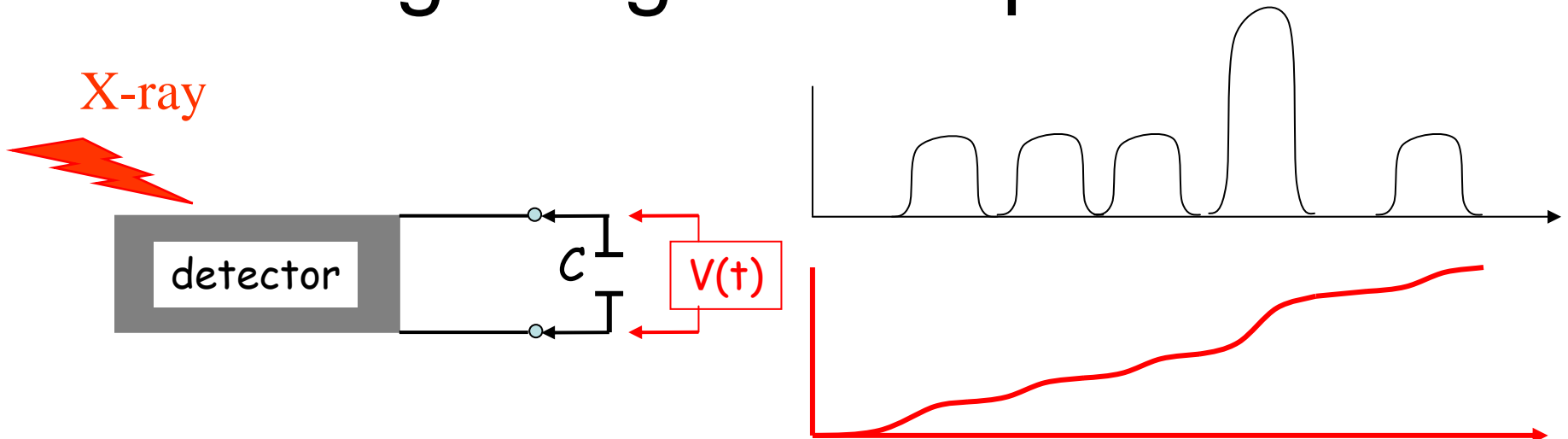




# Current mode operation

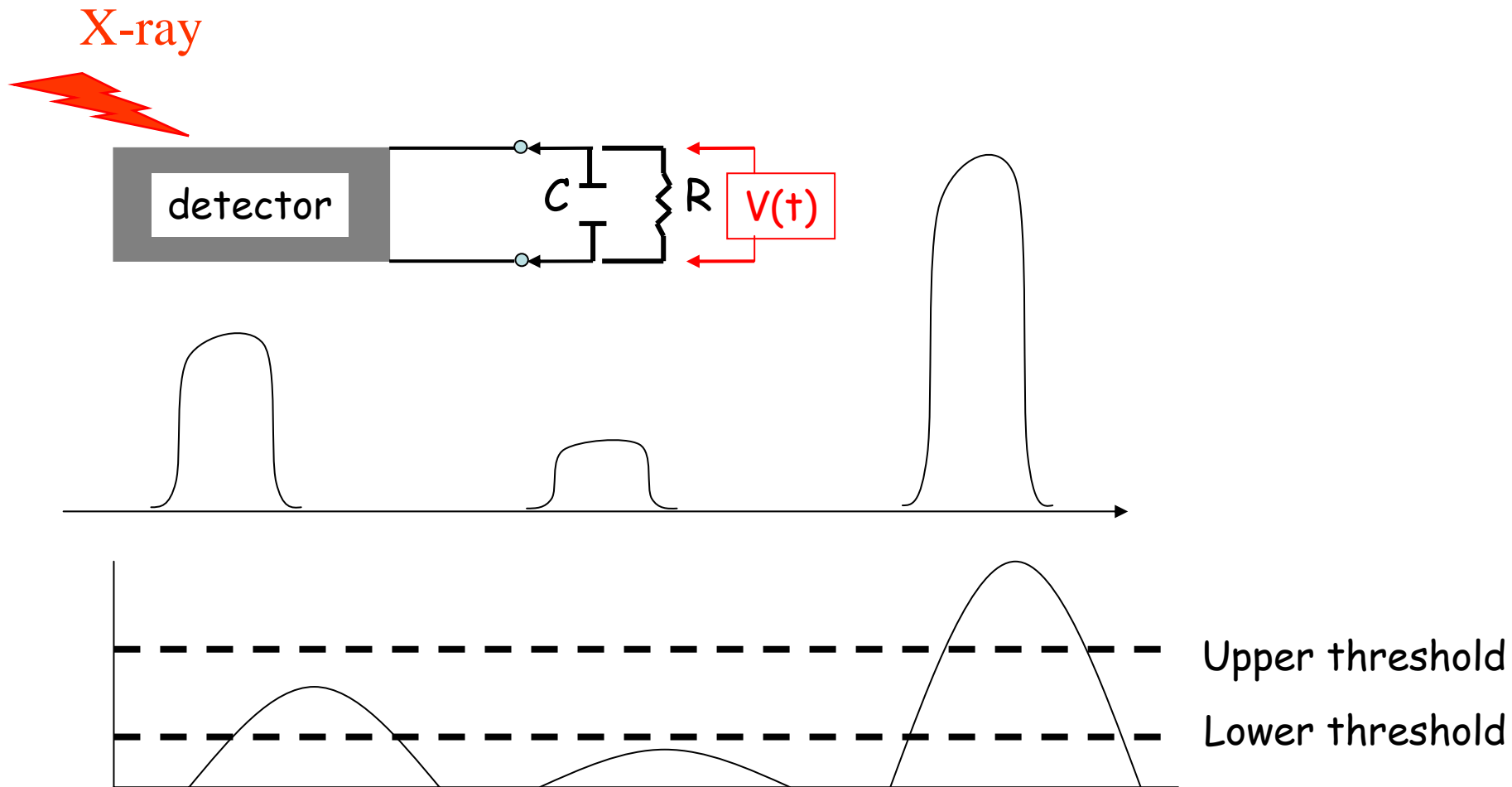


# Integrating mode operation



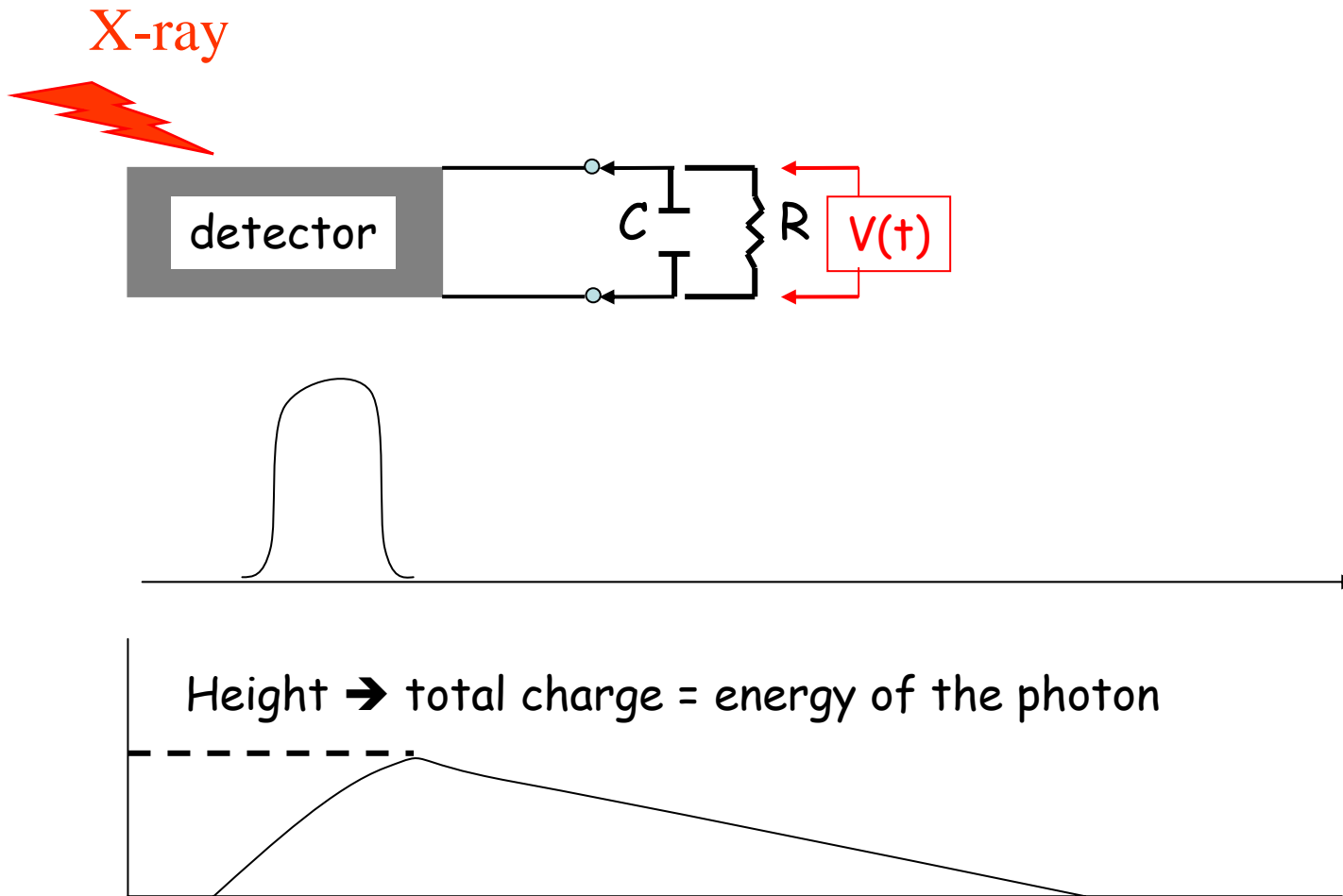


# Photon counting mode





# Energy dispersive mode





# Some general detector parameters

- **QE** = quantum efficiency = fraction of incoming photons detected (<1.0). You want this to be as high as possible.
- **DQE** = detective quantum efficiency =

$$\frac{(signal/noise)_{out}}{(signal/noise)_{in}} \leq 1.0$$

You can never increase signal, nor decrease noise! So signal to noise will always degrade in the detector. (NB: **signal to noise is the most important parameter** when you measure something!)

- **Gain** = relation between your signal strength (V, A, **ADU**) and the number of photons.

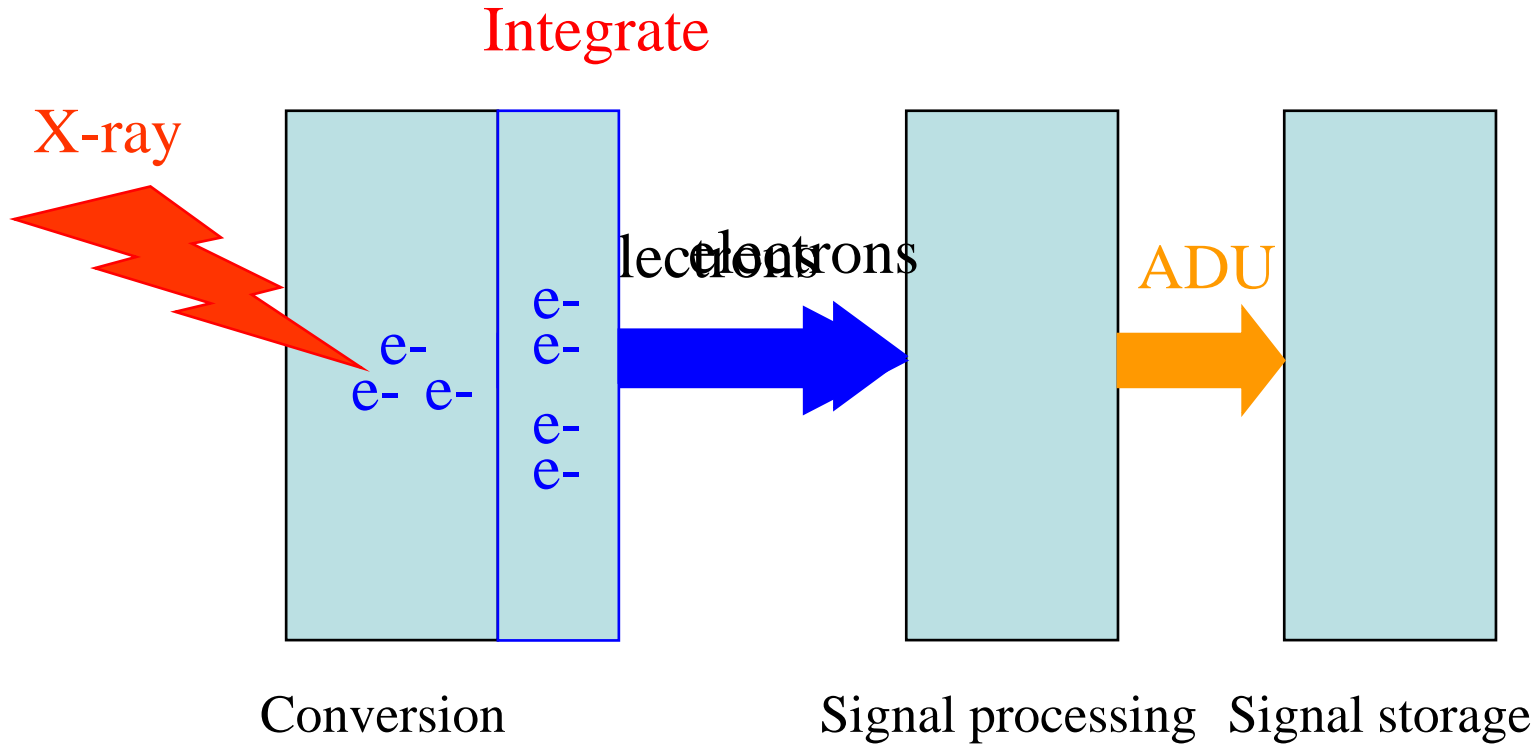


# 2-Dimensional X-ray Detectors

- Workhorses at synchrotron sources → make the best use of the available photons.
- Integrating versus counting
- Direct versus indirect detections

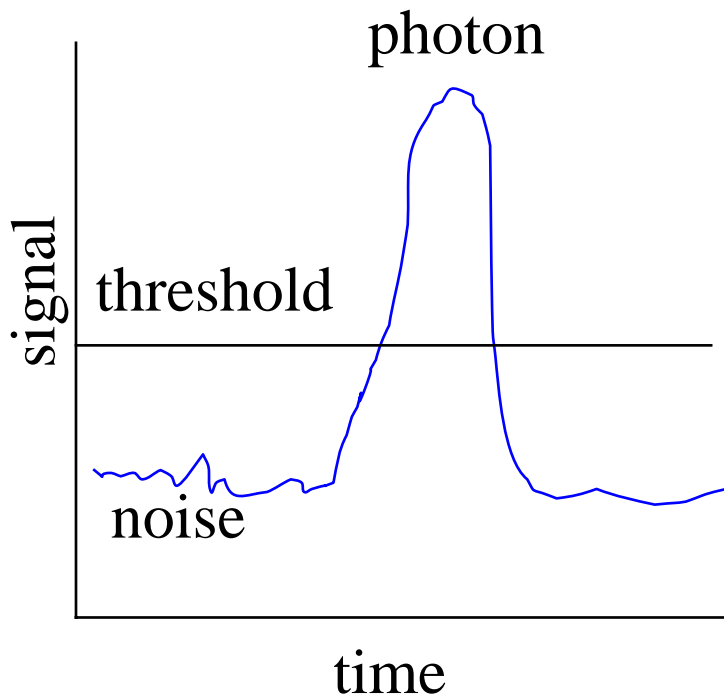


# Counting versus Integrating

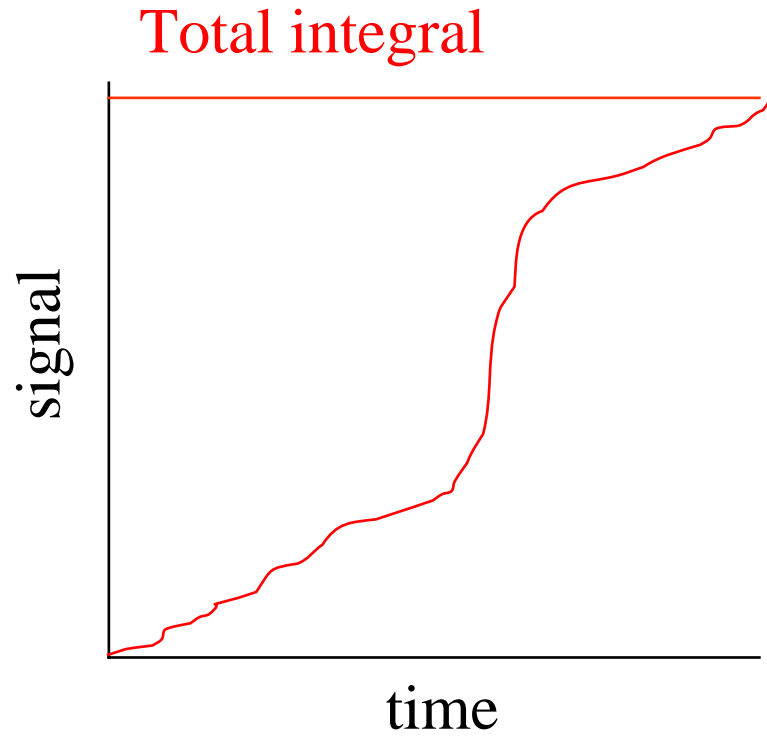




# Counting versus Integrating



**Low noise**



**Fast**

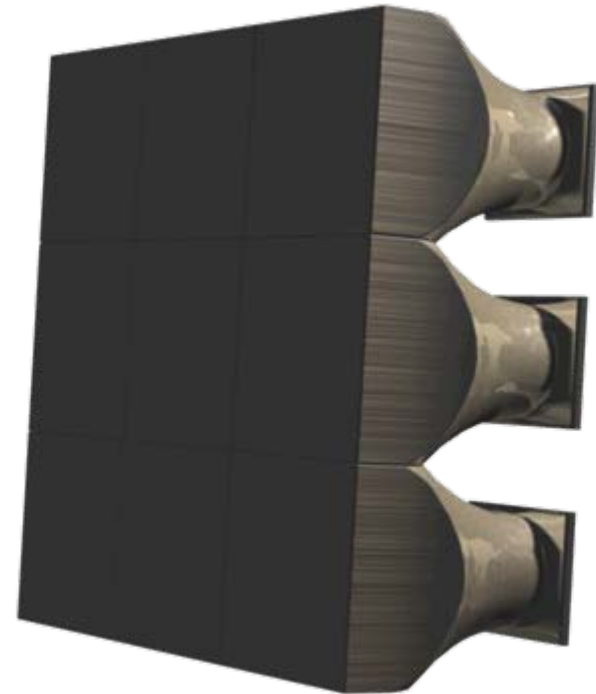
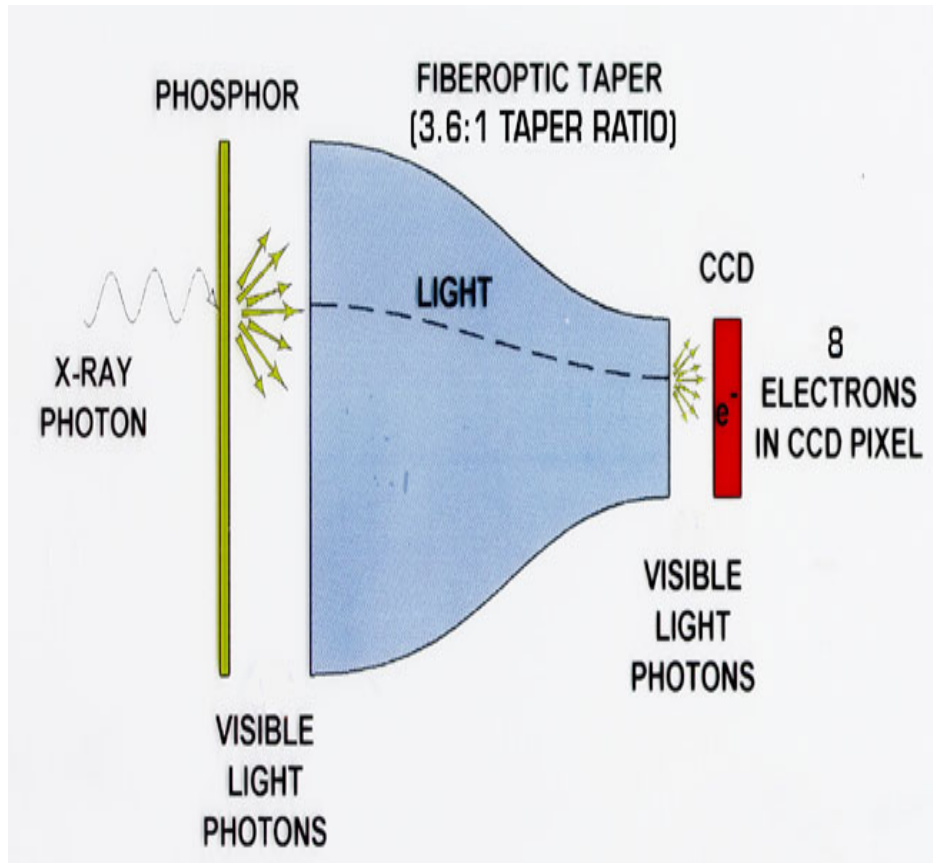


# CCD = Charge Coupled Devices

- **Very thin silicon** layer that transfers photons into electrons → not good for X-rays → use intermediate scintillator/phosphor.
- **Storage wells** that store generated charge; including thermally induced charge = dark current → fast but noisy
- Readout of signal through **one readout node**; transfer charge from one pixel to the next towards readout node → long readout times
- **Small pixels**: 10 – 30 micrometer.
- Commercial product for large market → **perfect**



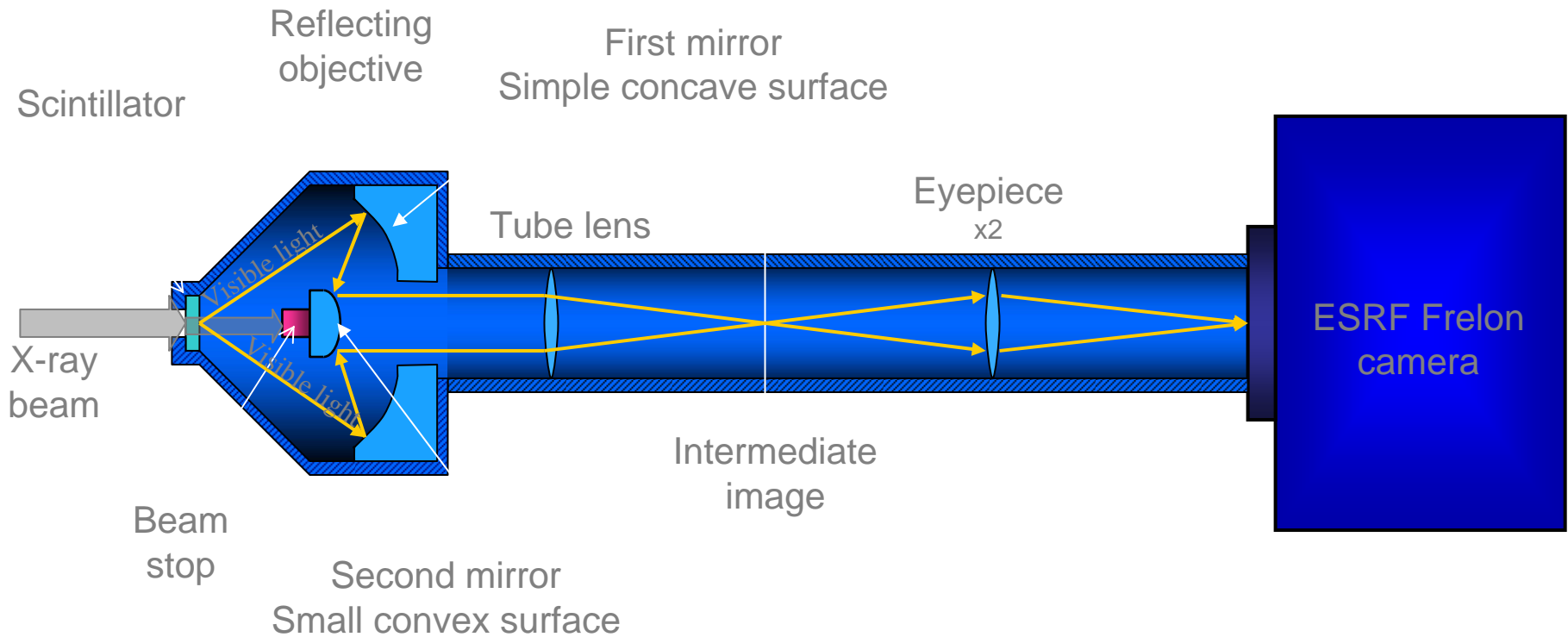
# Large area CCD systems, mainly for PX



– Indirect detection  
==> losses & spreading

– Integrating detector  
==> noise & information loss

# High resolution imaging with CCD's



**Scintillator is very inefficient**

**Full tomo dataset in < 1 sec.**



# Signal Generation → Needs transfer of Energy

Any form of elementary excitation can be used to detect the radiation signal:

Ionization (gas, liquids, solids)

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Breakup of Cooper pairs in superconductors

Typical excitation energies:

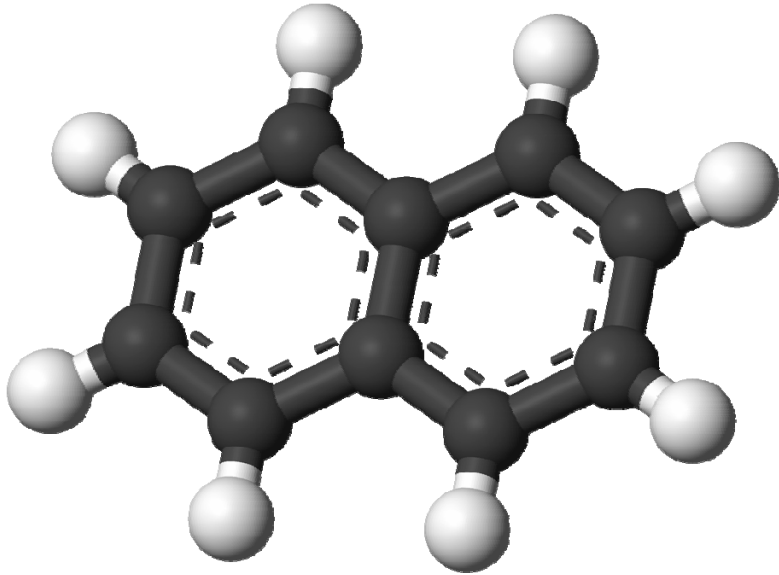
Ionization in semiconductors: 1 - 5 eV

Scintillation: appr. 20 eV

Phonons: meV

Breakup of Cooper pairs: meV

## A) Organic (molecular) scintillators



Naphtalene:  
 $\pi$ -electron system

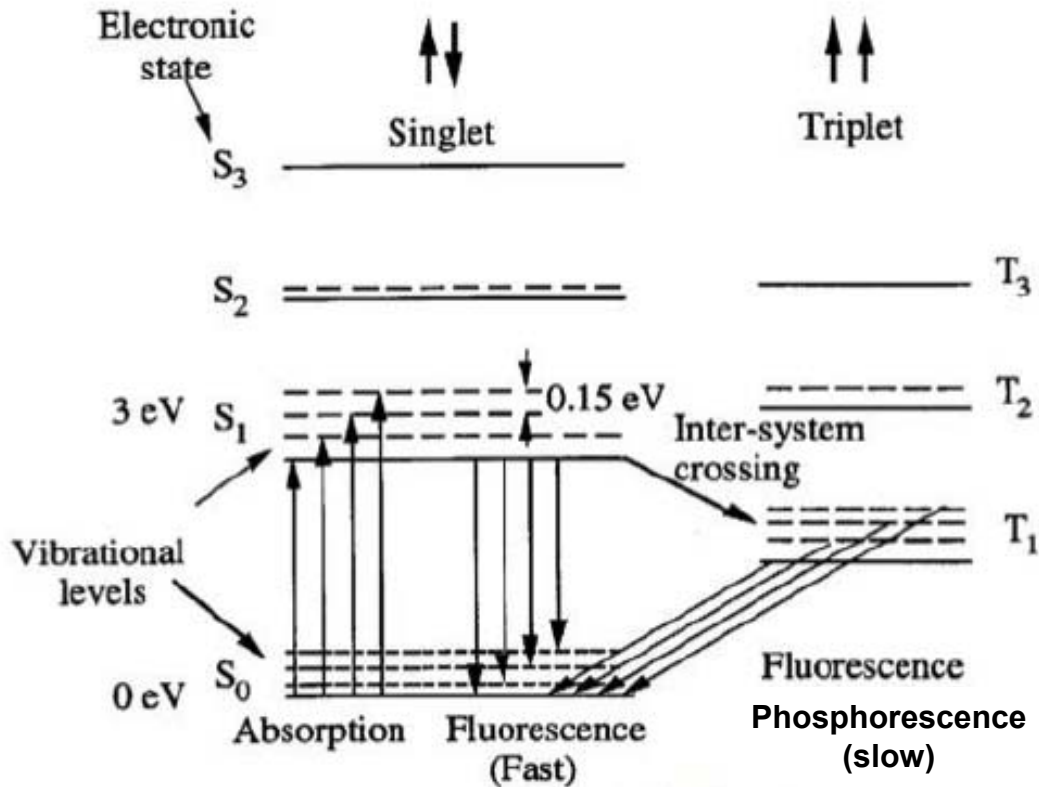
### Advantages:

- Fast
- No need for Xtals  
→ liquids, glasses, ...

### Disadvantages:

- inefficient
- Non-linear (quenching)
- not good for  $\gamma$ 's

# The electronic levels:



„Stokes-Shift“ => Transparenz

- 1) Prompt fluorescence
  - 2) Phosphorescence
  - 3) Delayed fluorescence
- ➔ Complicated time structure



## **b) Inorganic crystalline scintillators (NaI:TI)**

Origin does not stem from molecular energy levels but from band-structure levels.

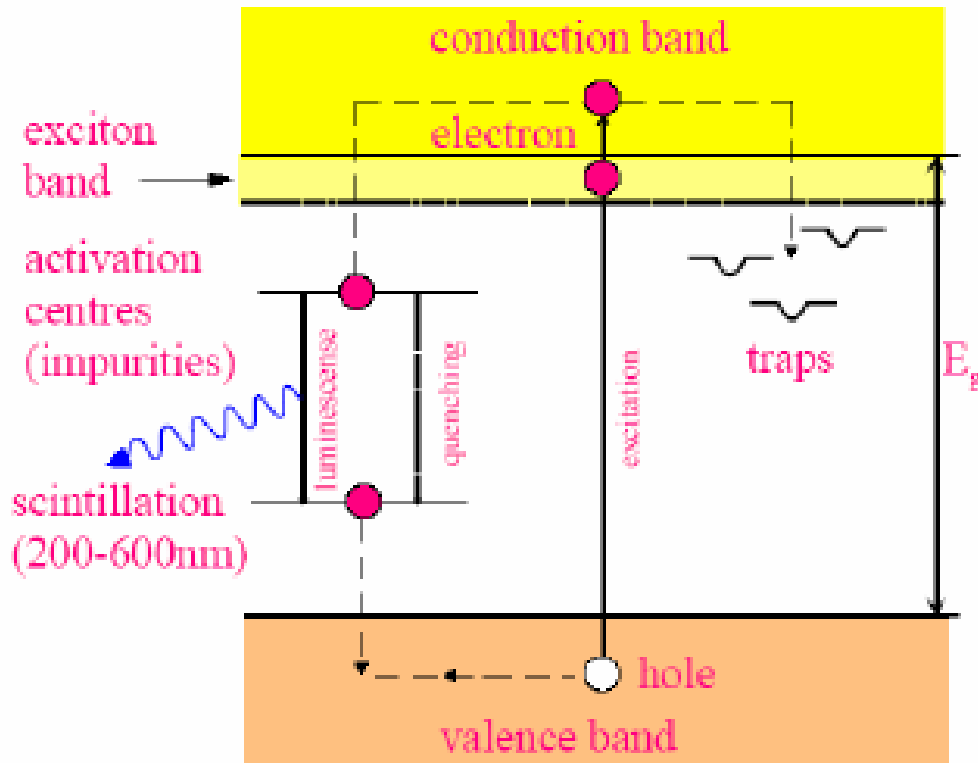
### **Advantages:**

- Good efficiency
- Good linearity
- Radiation tolerance

### **Disadvantages:**

- Relatively slow
- Crystal structure needed (small and expensive)

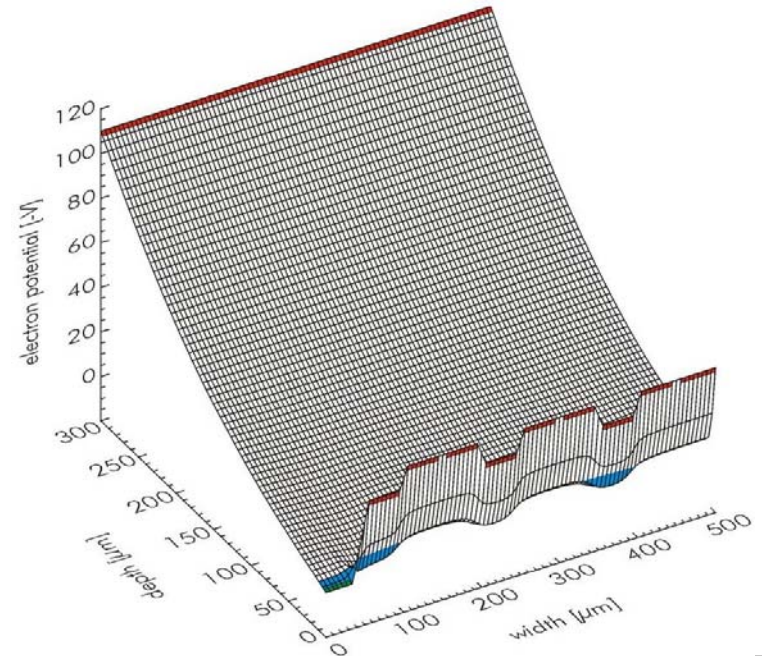
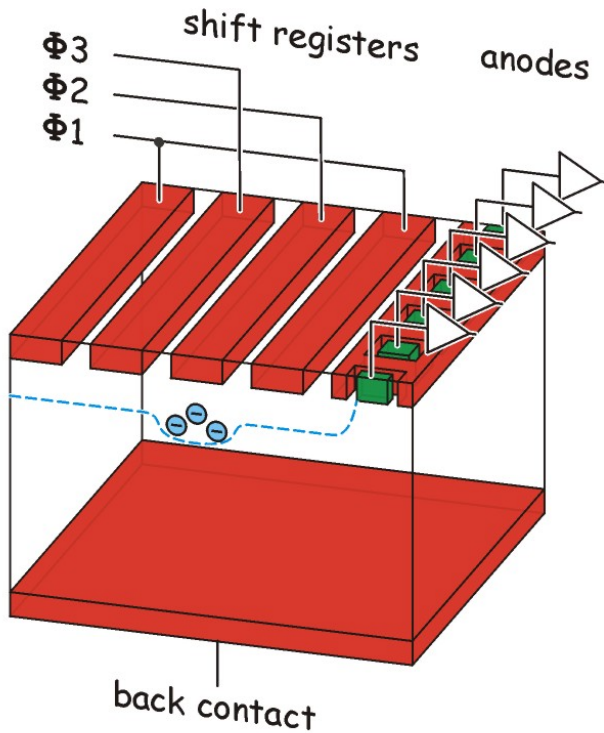
# Three different scintillation mechanisms (crystals like NaI, CsI, BGO, BaF<sub>2</sub>, ...)



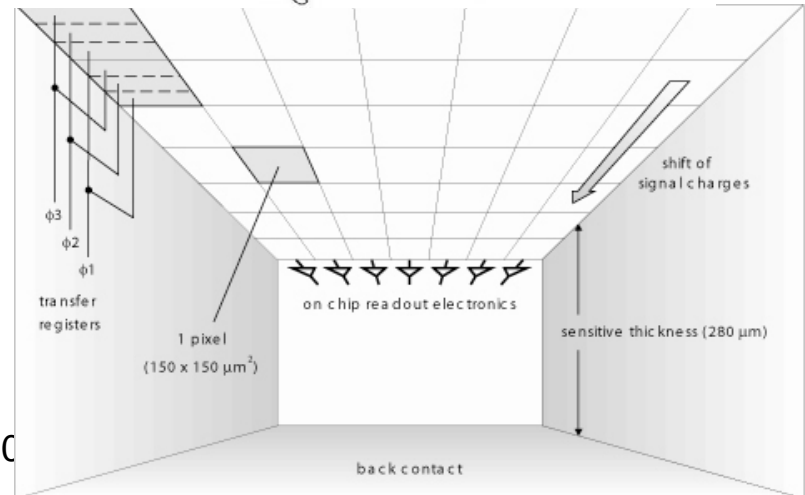
→ > 1 decay time constants

- **fast** recombination (ns ...  $\mu$ s) from activation centres
- **slow** recombination due to trapping (~100ms)

# Direct detection pnCCD



- full depletion (50  $\mu\text{m}$  to 500  $\mu\text{m}$ )
- back side illumination
- high readout speed
- pixel sizes from 36  $\mu\text{m}$  to 650  $\mu\text{m}$
- charge handling: more than  $10^6$  e<sup>-</sup>/pixel
- high quantum efficiency







# How many charges can be stored in one pixel ?

What determines the charge handling capacity in a pixel ?

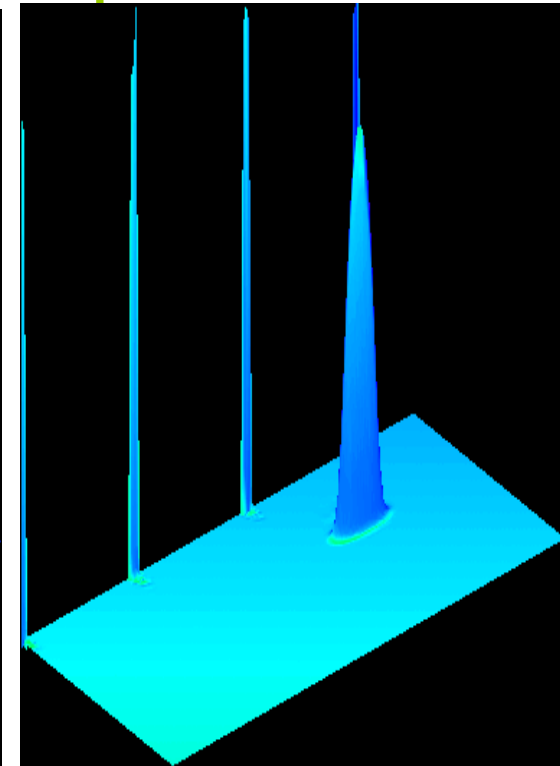
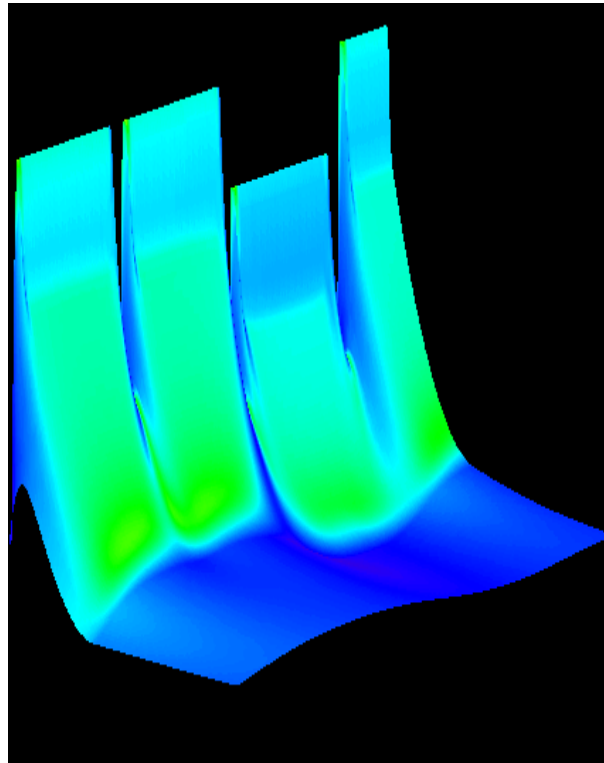
**pixel volume:**

$$20 \times 40 \times 12 \mu\text{m}^3 \approx 1 \times 10^4 \mu\text{m}^3$$

**Doping:**  $10^2$  P per  $\mu\text{m}^3$

**CHC** =  $1 \times 10^6$  per pixel

can be increased by doping





# The new generation 2D detectors: Hybrid Pixel Array Detectors

What are they?  
and  
why are they so good?



# Hybrid Pixel Array Detector (HPAD)

## Diode Detection Layer

- Fully depleted, high resistivity
- Direct x-ray conversion
- Silicon, GaAs, CdTe, etc.

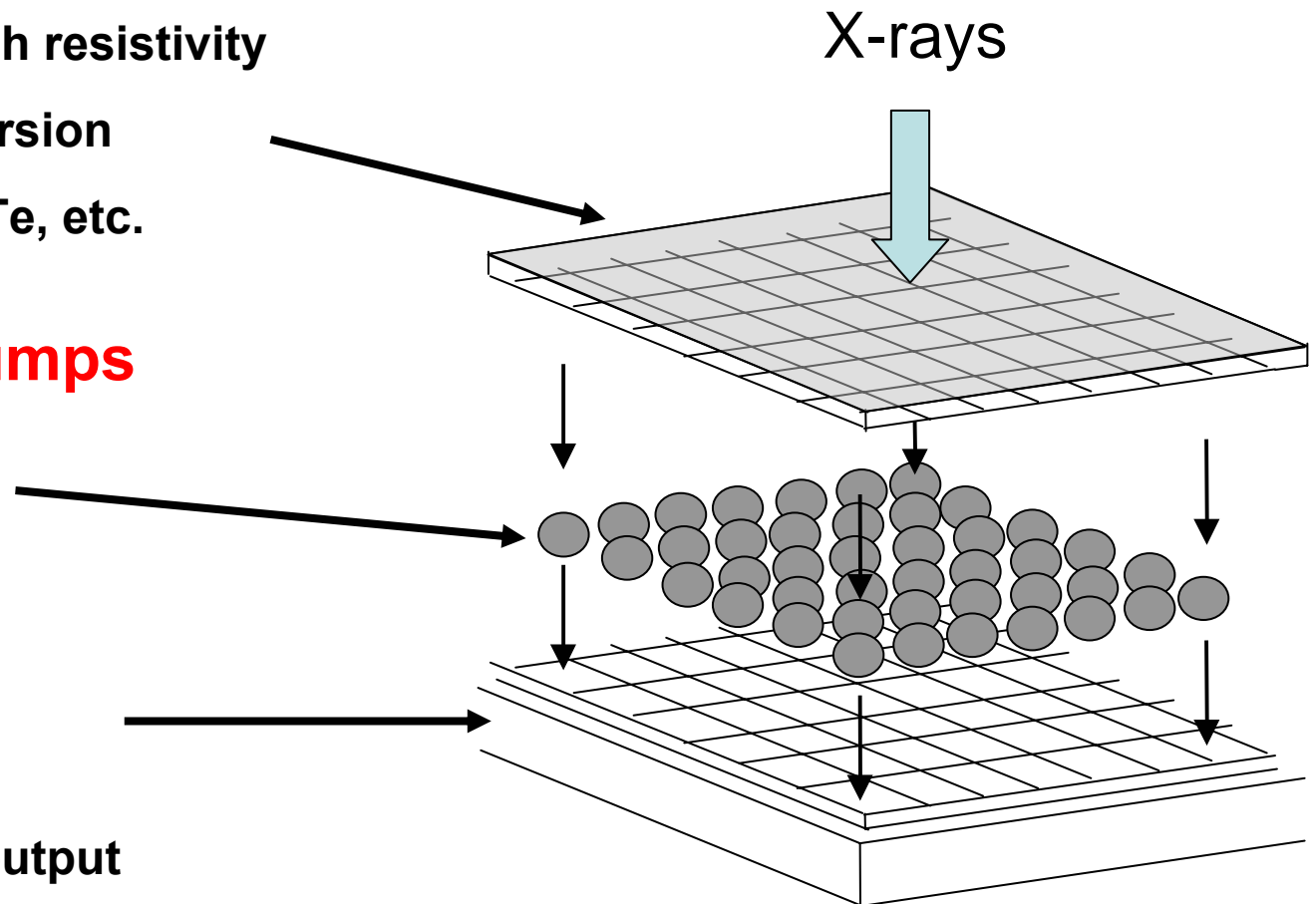
## Connecting Bumps

- Solder or indium
- 1 per pixel

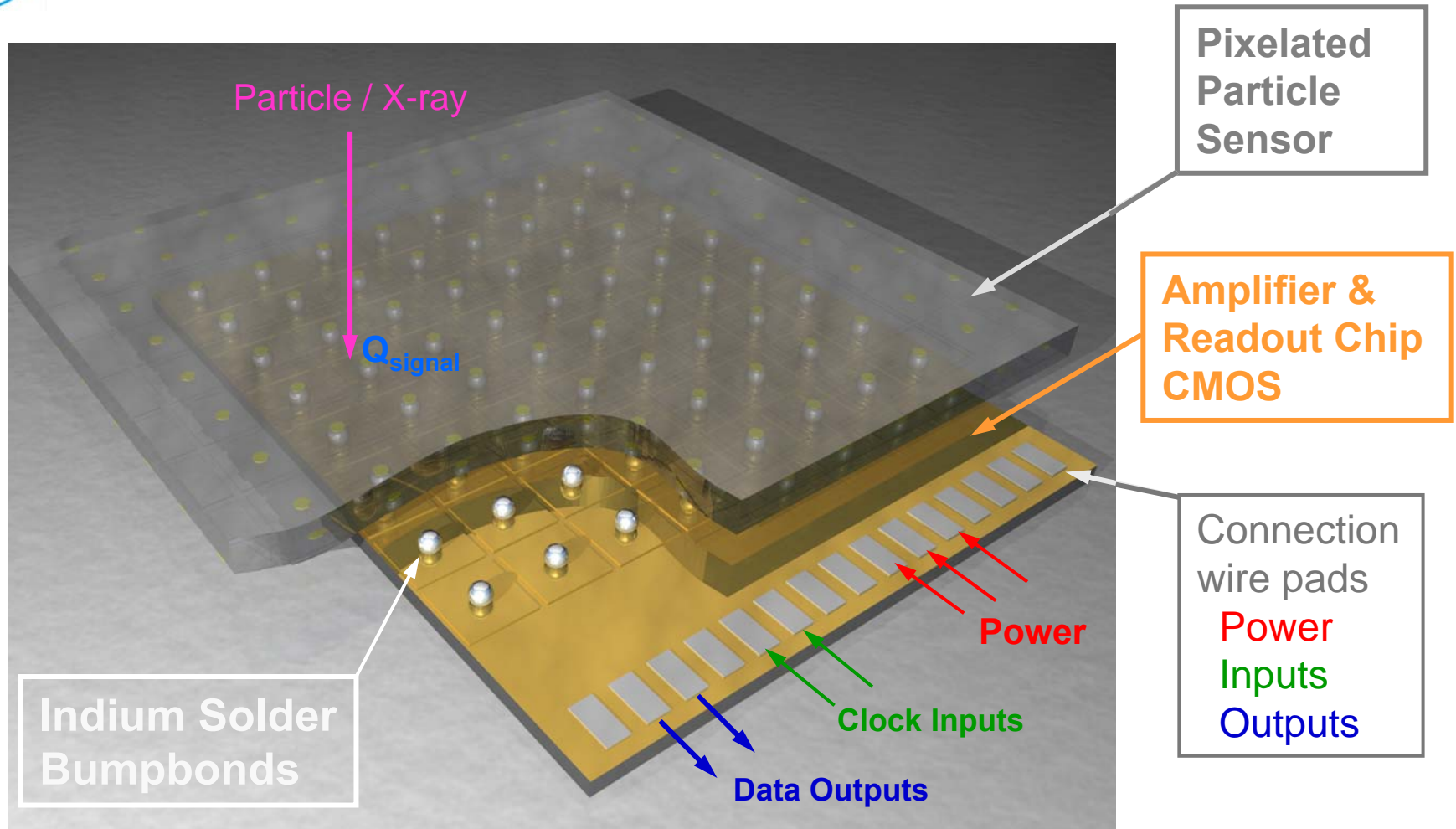
## CMOS Layer

- Signal processing
- Signal storage & output

*Gives enormous flexibility!*



# Hybrid Pixel Detectors



Particle / X-ray → Signal Charge → Electr. Amplifier → Readout → Digital Data



# Signal Generation → Needs transfer of Energy

Any form of elementary excitation can be used to detect the radiation signal:

**Ionization (gas, liquids, solids)**

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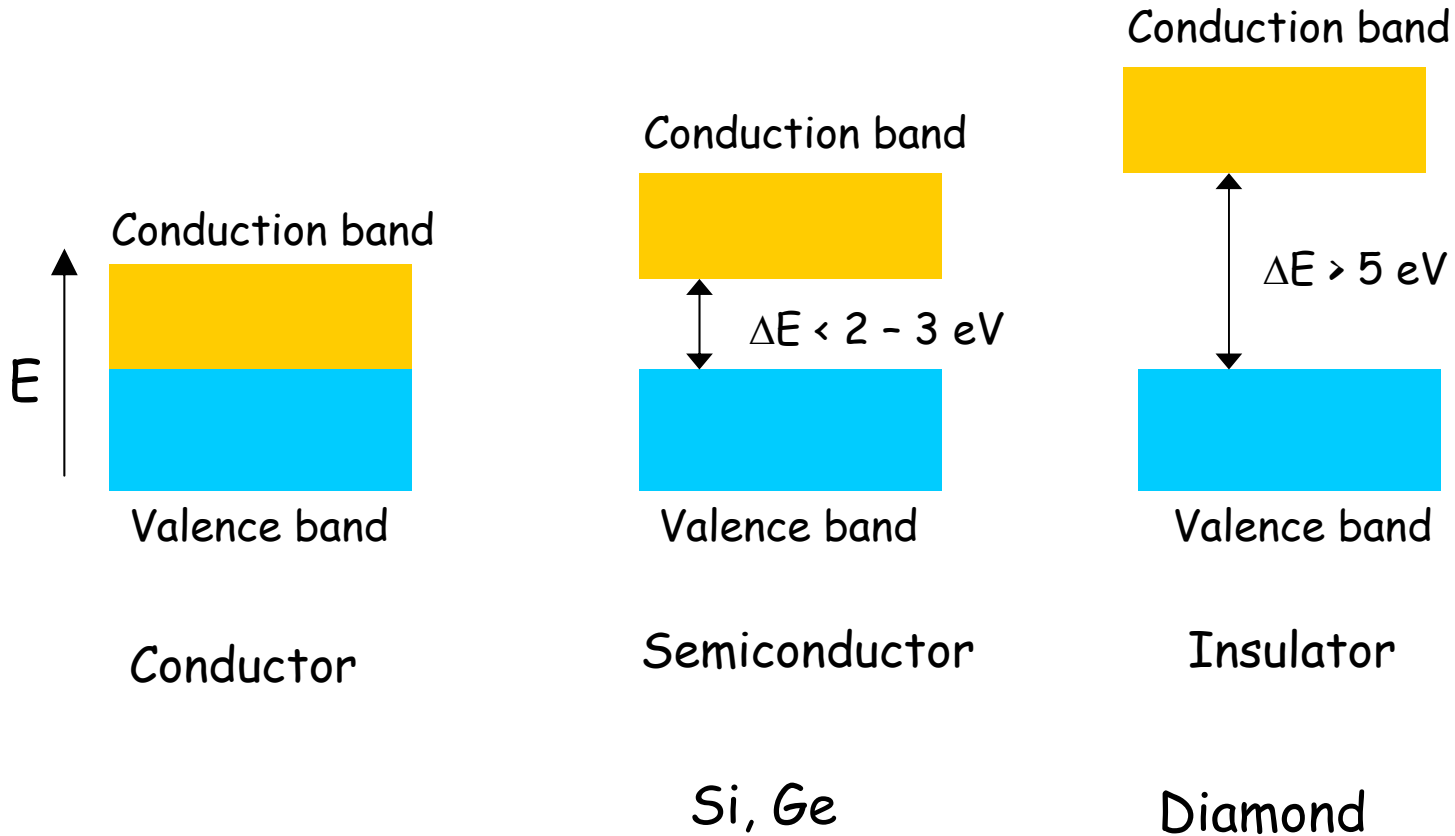
Scintillation: appr. 20 eV

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Breakup of Cooper pairs: meV

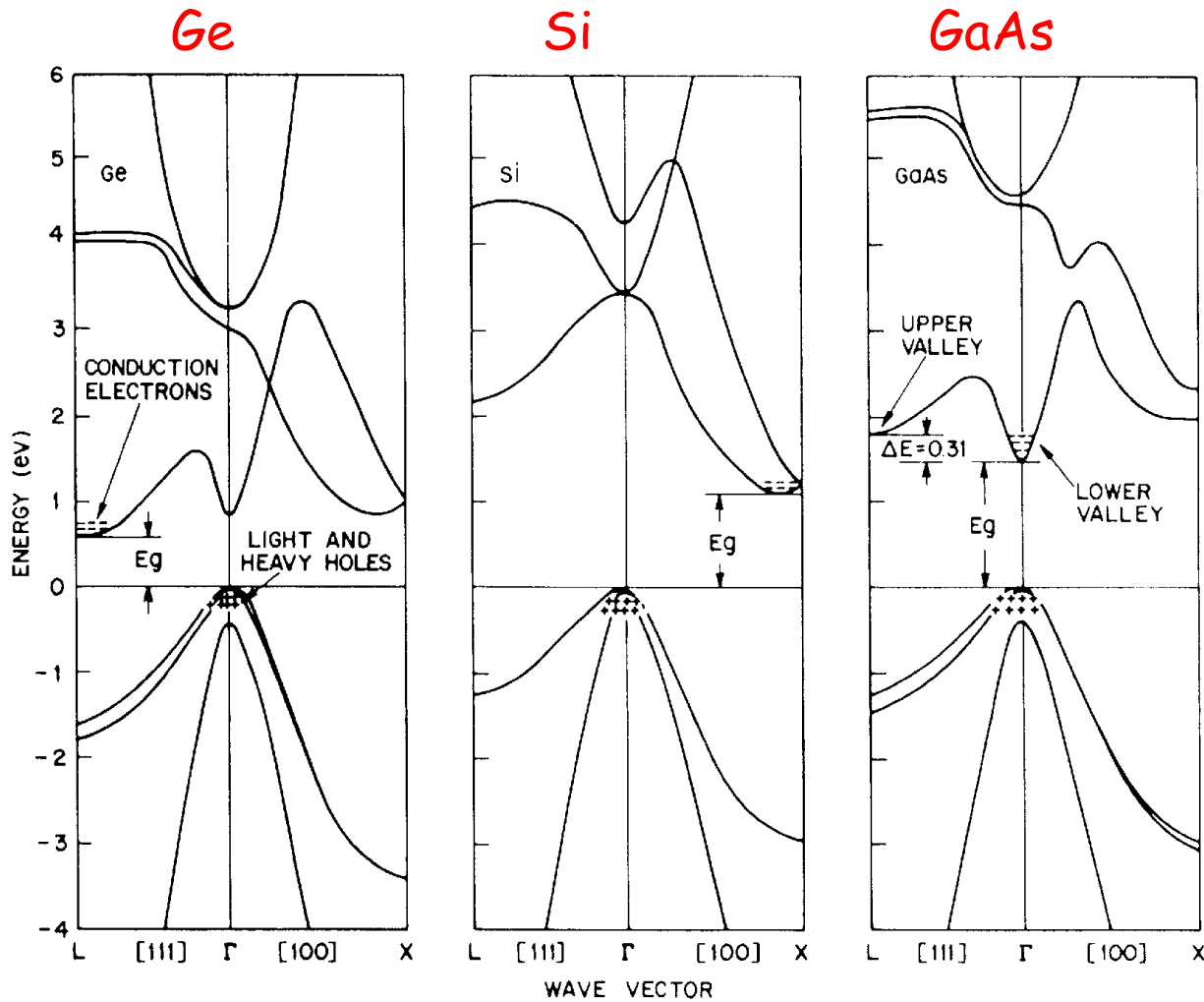


# Classification of Conductivity





# Band structure (3)



$E_g = 0.7 \text{ eV}$

$E_g = 1.1 \text{ eV}$

$E_g = 1.4 \text{ eV}$

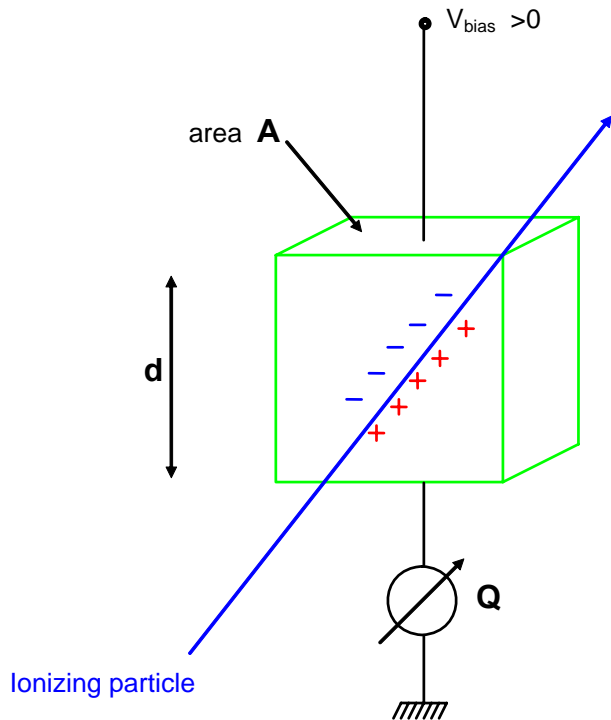
Indirect band gap

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Direct band gap

# „Ohmic“ Particle Detector

Ohmic material : Resistivity  $\rho$  e.g. intrinsic semiconductor



- **E-field** :  

$$E = V_{\text{bias}} / d$$
- **Carrier velocity** :  

$$v = \mu E = \mu (V_{\text{bias}} / d)$$
- **Signal collection time** :  

$$\tau = d / v = d^2 / (\mu V_{\text{bias}})$$
- **Resistance** :  

$$R = \rho (d / A)$$
- **„leakage current“** :  

$$i_{\text{leak}} = V_{\text{bias}} / R = (V_{\text{bias}} A) / (\rho d)$$
- **„leakage charge“** :  

$$Q_{\text{leak}} = i_{\text{leak}} \tau = d A / \rho \mu$$

$$Q_{\text{leak}} = \text{Volume} / \rho \mu$$





**Example :** Silicon  $\rho = 20 \text{ k}\Omega\text{cm}$

$d = 300\text{mm}$  , Signal charge =  $4f\text{Clb} = 24'000 \text{ e}$

- Pad detector :  $A = 1 \text{ cm}^2$

$$Q_{\text{leak}} = 10^{-9} \text{ Clb} \text{ ---> } \sigma \sim 80'000 \text{ e} \text{ ---> } \text{S/N} \sim 0.3$$

- Pixel detector :  $100\mu\text{m} \times 100\mu\text{m}$  --->  $A = 10^{-4} \text{ cm}^2$

$$Q_{\text{leak}} = 10^{-13} \text{ Clb} \text{ ---> } \sigma \sim 800 \text{ e} \text{ ---> } \text{S/N} \sim 30 \text{ !!!!}$$

The operation of semiconductor materials in a “ohmic” regime works fine for:

- Silicon ( $\Delta E_{\text{bandgap}} = 1.16\text{eV}$ ) at low temperature
- High bandgap semiconductors ( GaAs, Diamond) at room temperature

**However, for Silicon at room temperature need another trick !**

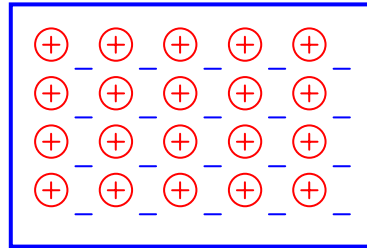
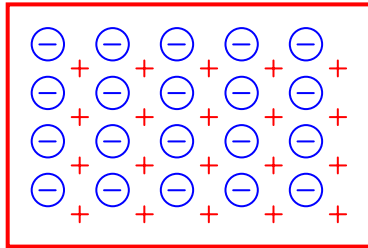


# p-n-junction and space charge region

fixed charges :  $\ominus$   $\oplus$   
 mobile charges:  $+$   $-$

p-type

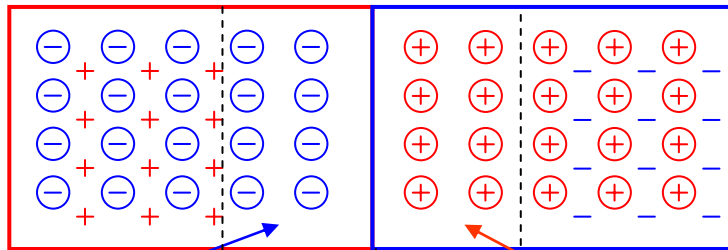
n-type



p-n-junction **before** equalization of Fermi levels

acceptor density  $N_A$

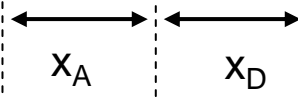
donor density  $N_D$



p-n-junction **after** equalization of Fermi levels

negative space charge region

positive space charge region



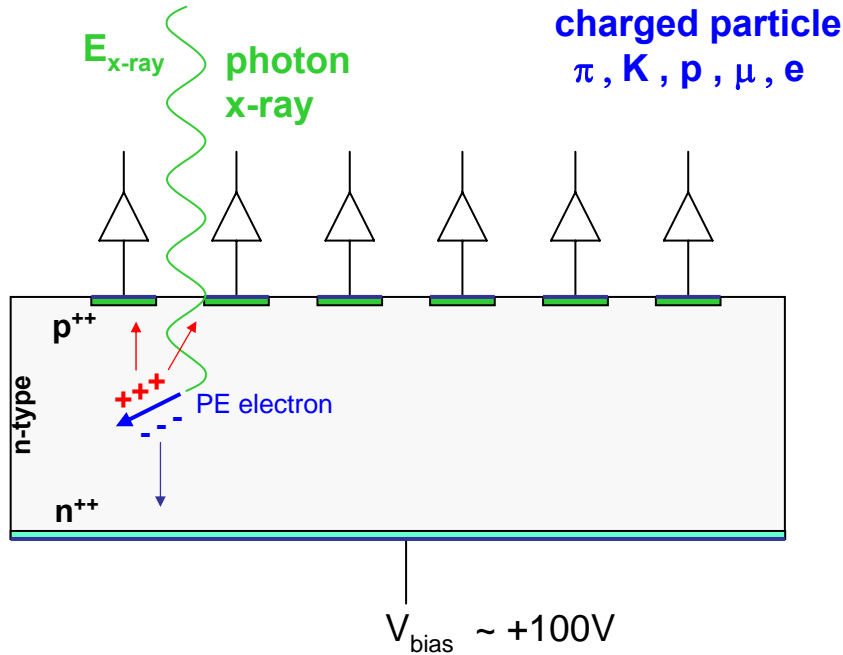
region free of mobile carriers !  $\rightarrow$  no leakage current !

charge neutrality  $\rightarrow$

$$N_A \cdot x_A = N_D \cdot x_D$$



# Segmented Silicon Diode Sensors for Particle Detection



Shared Charge collection on segmented electrodes due to:

- Diffusion during drift time
- Lorentzangle due to presence of B-field
- Tilted tracks

Individual readout of charge signal on electrodes allows **position interpolation** that is better than pitch of segmentation.

Silicon microstrip detectors in HEP:

Strip pitch =  $50\mu\text{m}$

Position resolution  $\sim 1.5\mu\text{m}$  achieved



# Hybrid Pixel Array Detector (HPAD)

## Diode Detection Layer

- Fully depleted, high resistivity
- Direct x-ray conversion
- Silicon, GaAs, CdTe, etc.

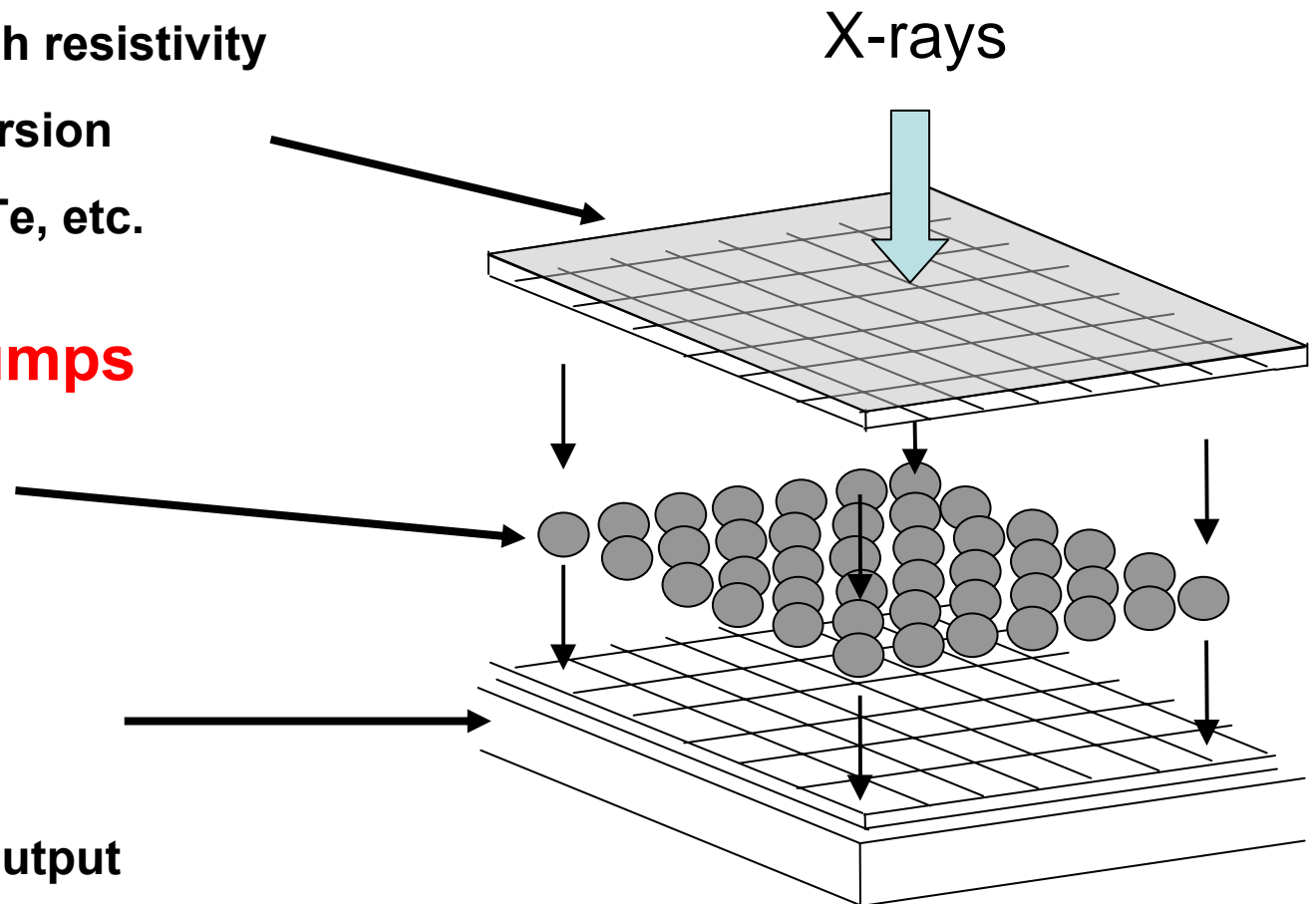
## Connecting Bumps

- Solder or indium
- 1 per pixel

## CMOS Layer

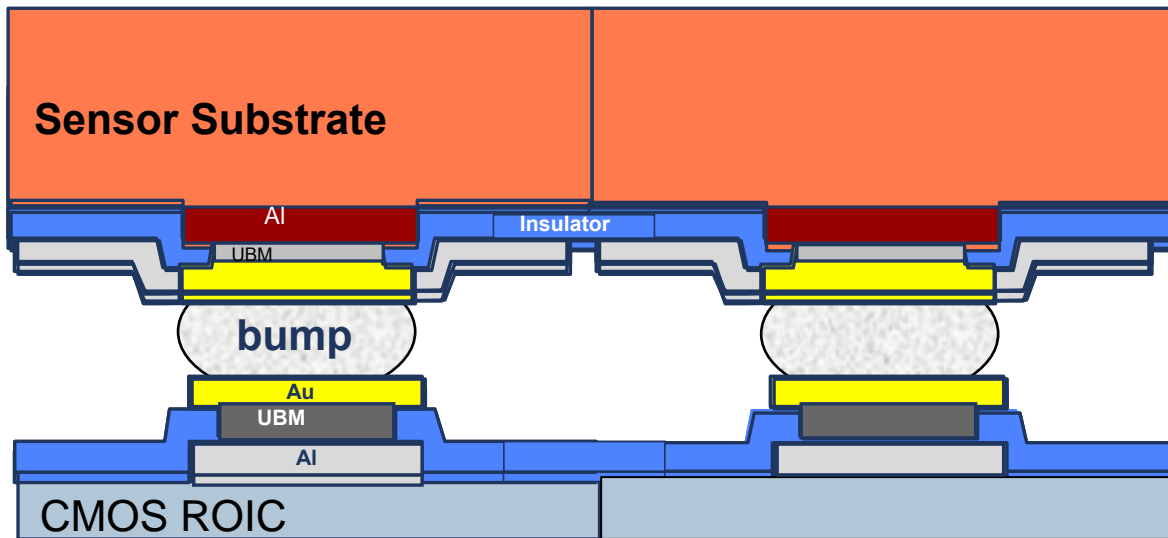
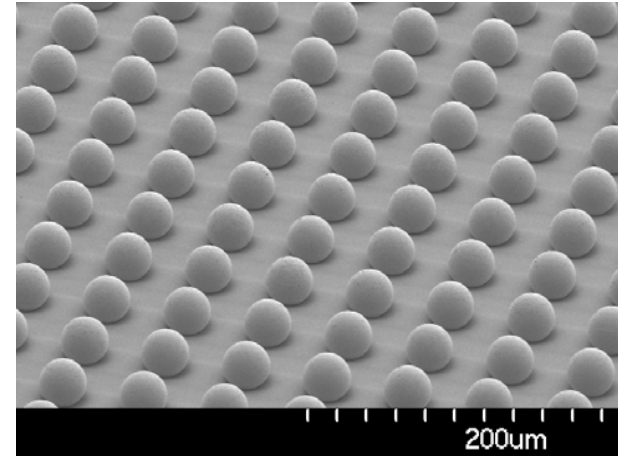
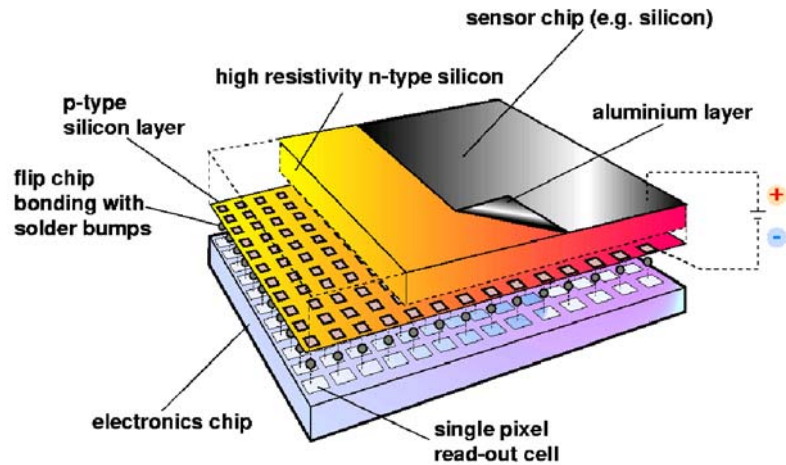
- Signal processing
- Signal storage & output

*Gives enormous flexibility!*





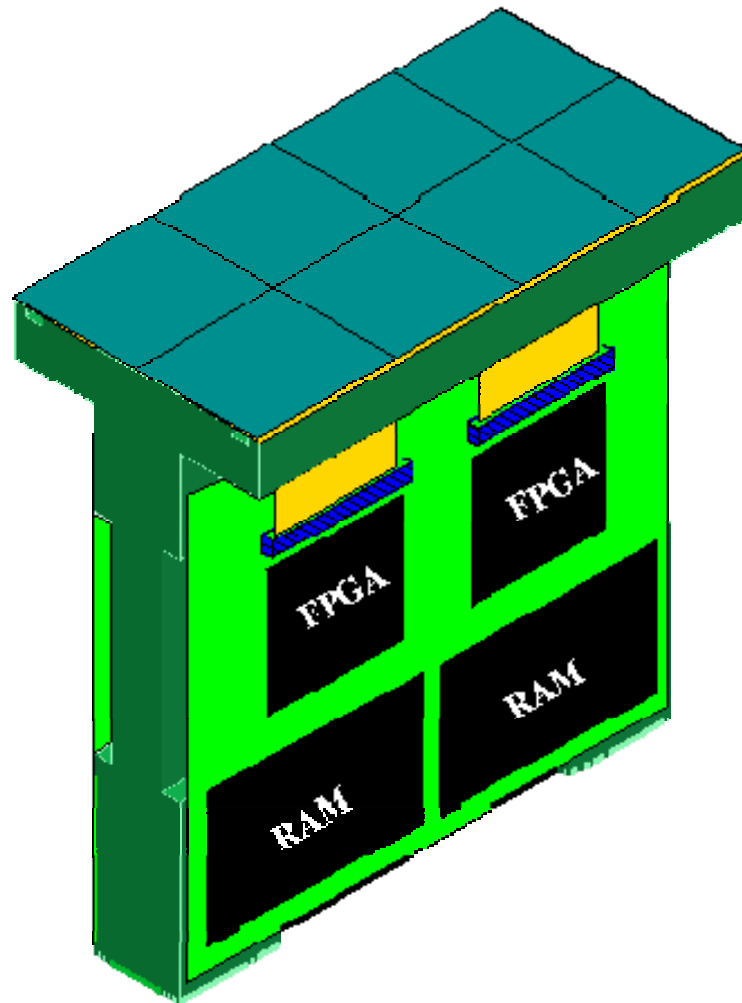
# The new generation: Medipix et al.



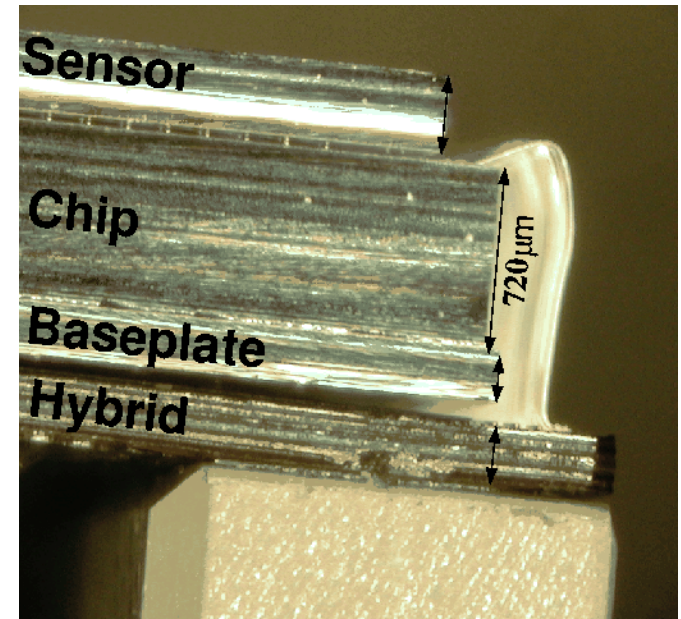
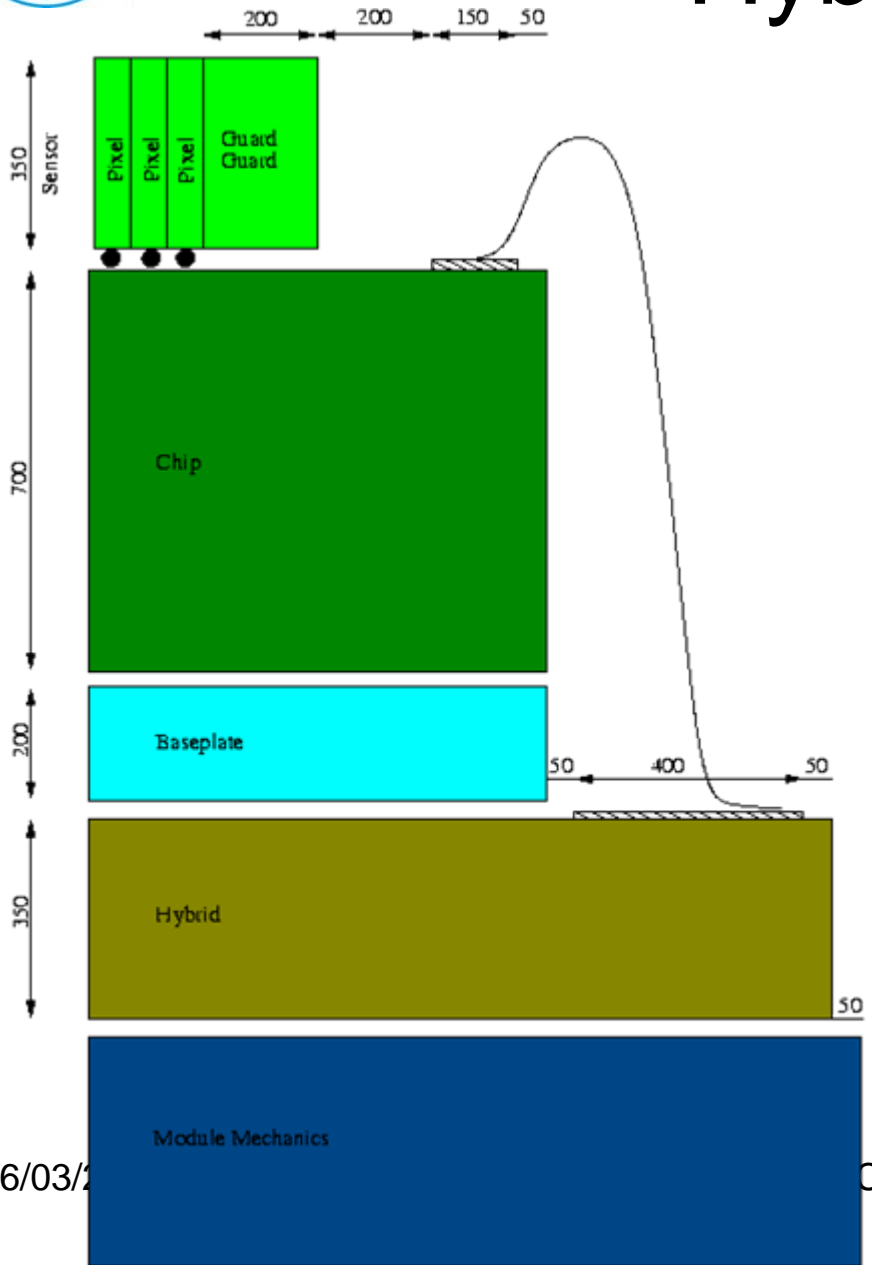


# XFS Module Specification: PSI/SLS

Operate **2x4 (8)** Chips per Module. **~78 x 39 mm<sup>2</sup>**



# Hybridization



- Cut the sensor as close as possible
- Use thinned readout chips
- Stay within the exact n-fold pixel pitch





**Courtesy: Ch. Brönnimann, PSI SLS Detector Group**  
HG-HERCULES-2009



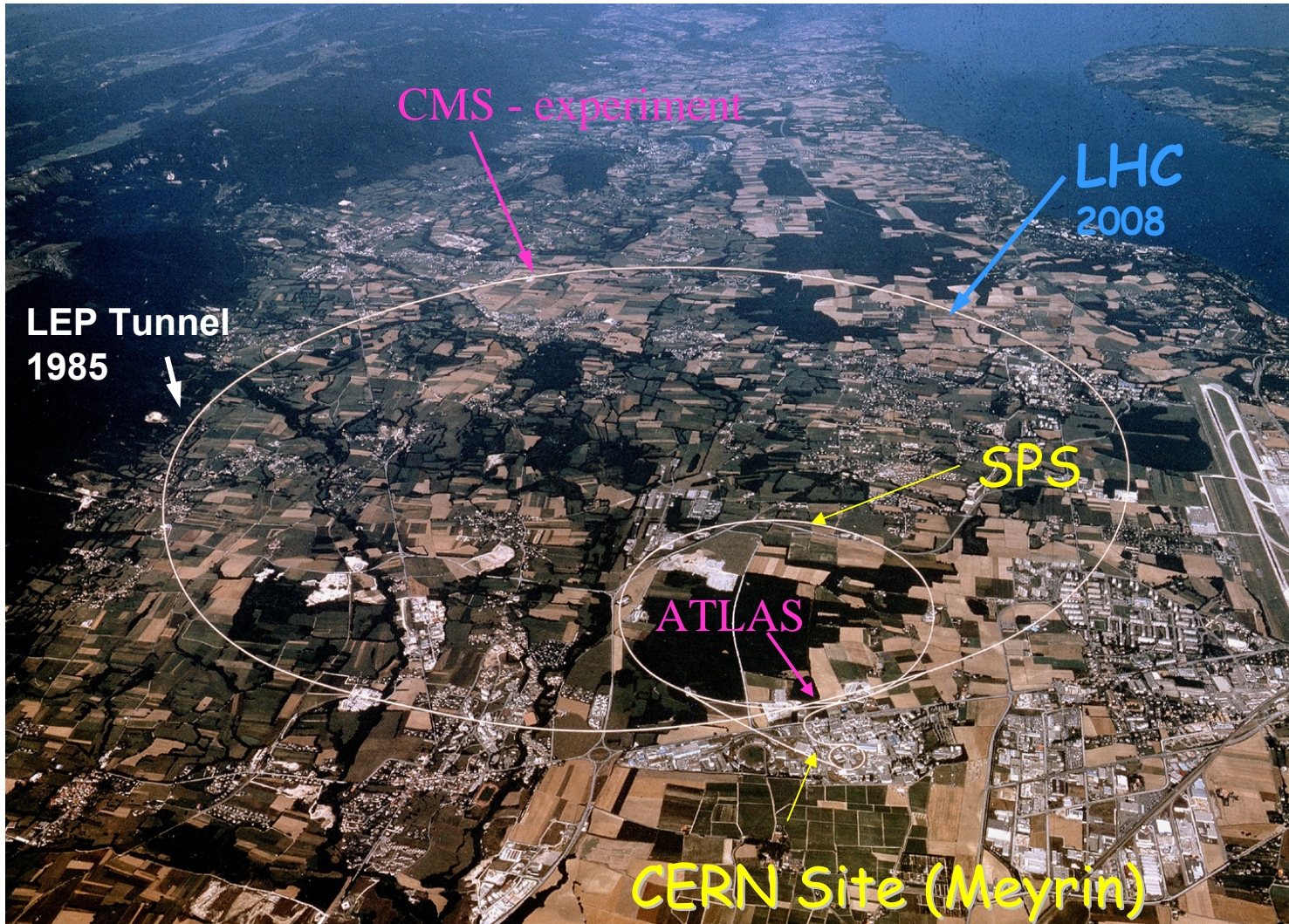


# Why are HPADs so popular ?

- Custom design of functionality: you design your readout chip specific for your application (unlike CCDs).
- Can do photon counting → “no” noise.
- Direct detection → good spatial resolution
- Massive parallel detection → high flux
- But: development takes long and is expensive.



# Large Hadron Collider LHC at CERN



**Proton – Proton collisions at 14 TeV → Higgs & SUSY search**

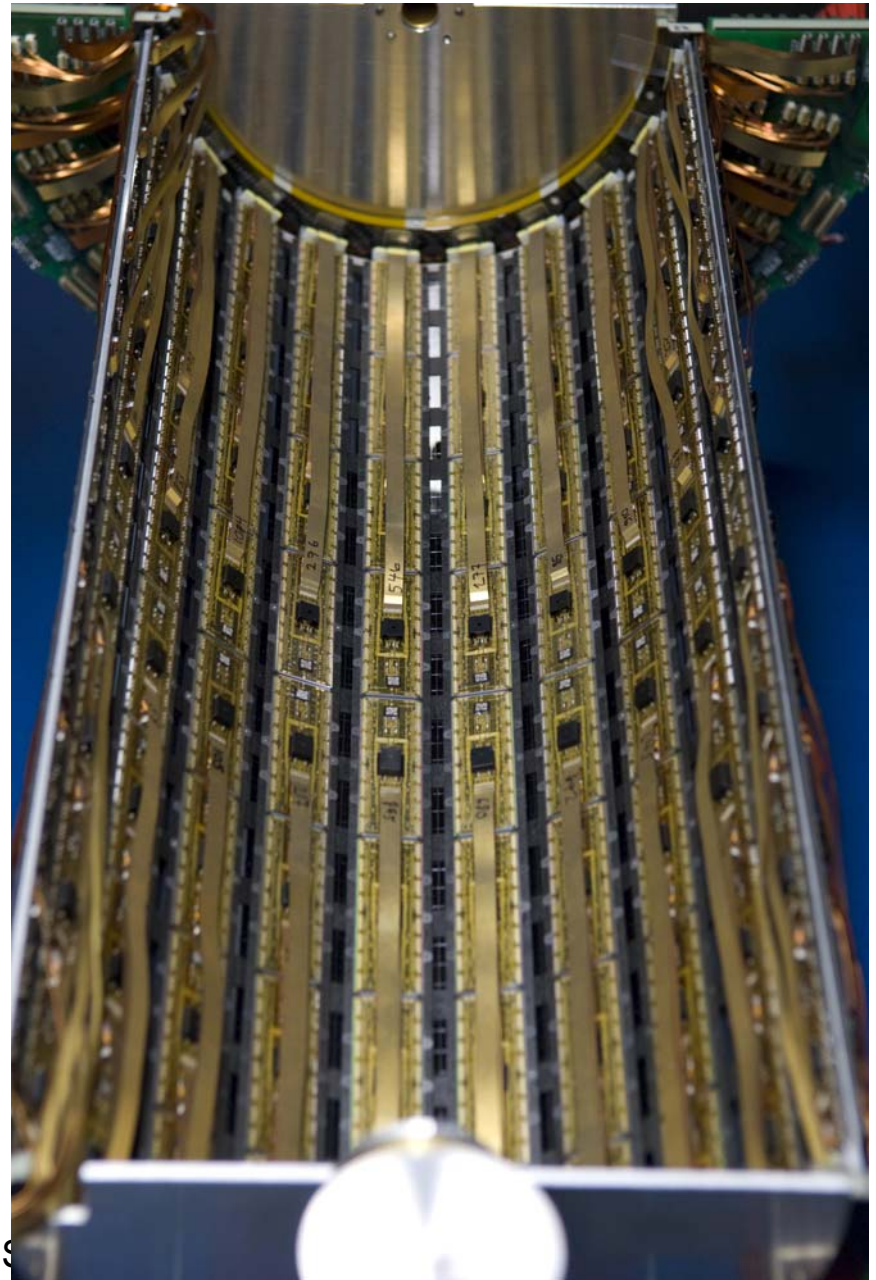
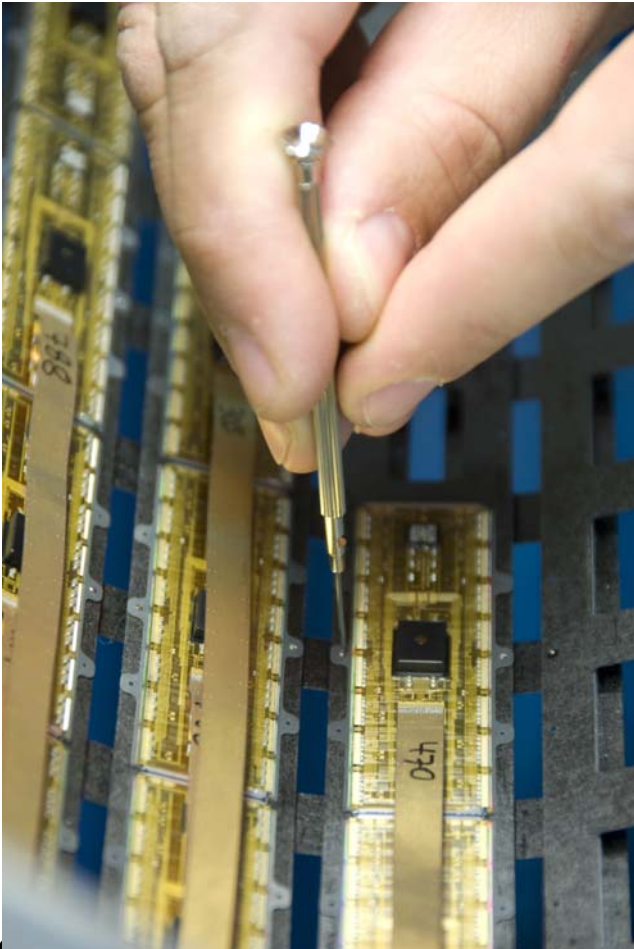




# CMS Pixel Detector

for the Large Hadron Collider

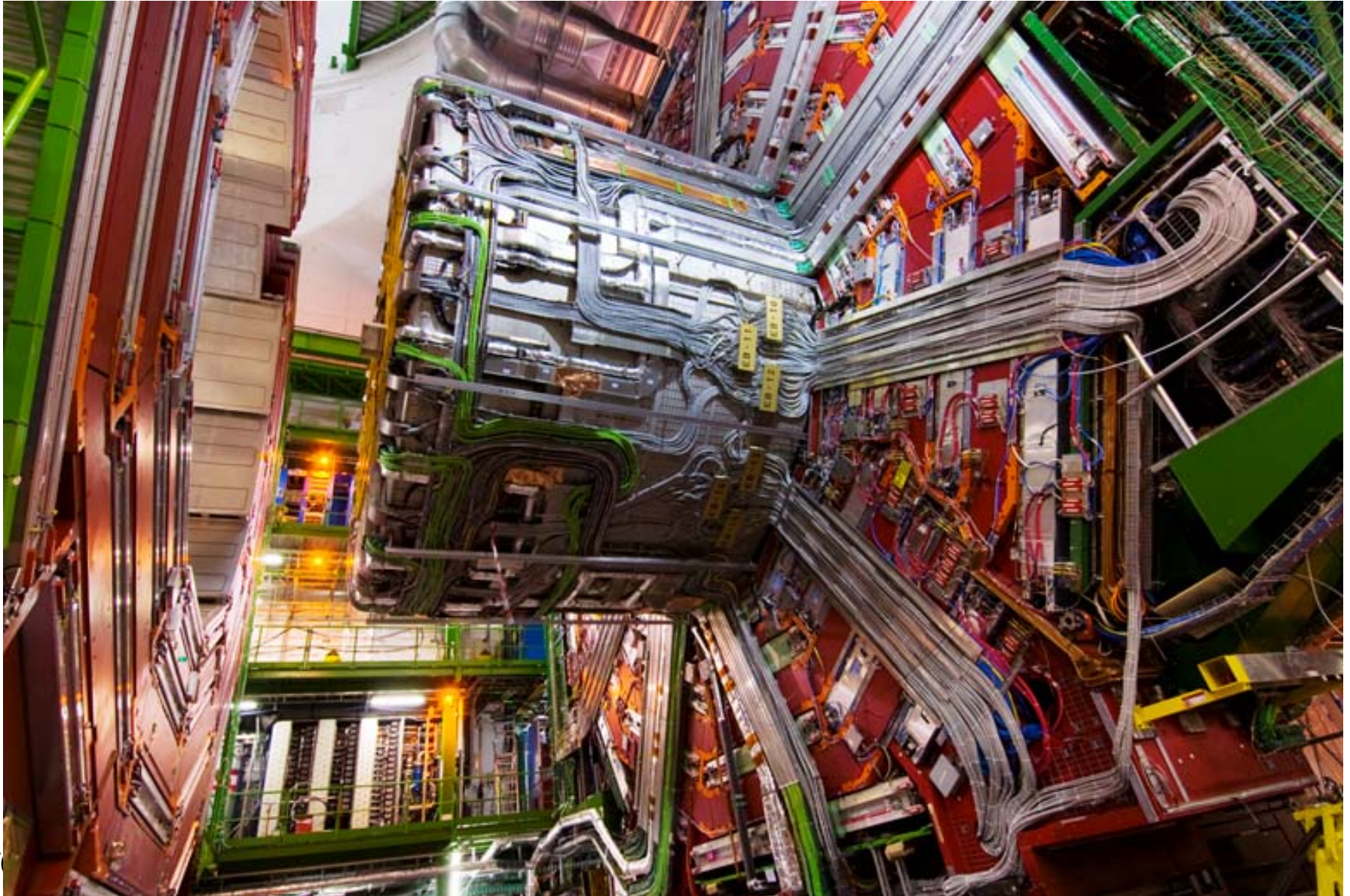
768 pixel modules  $\sim 0.75 \text{ m}^2$







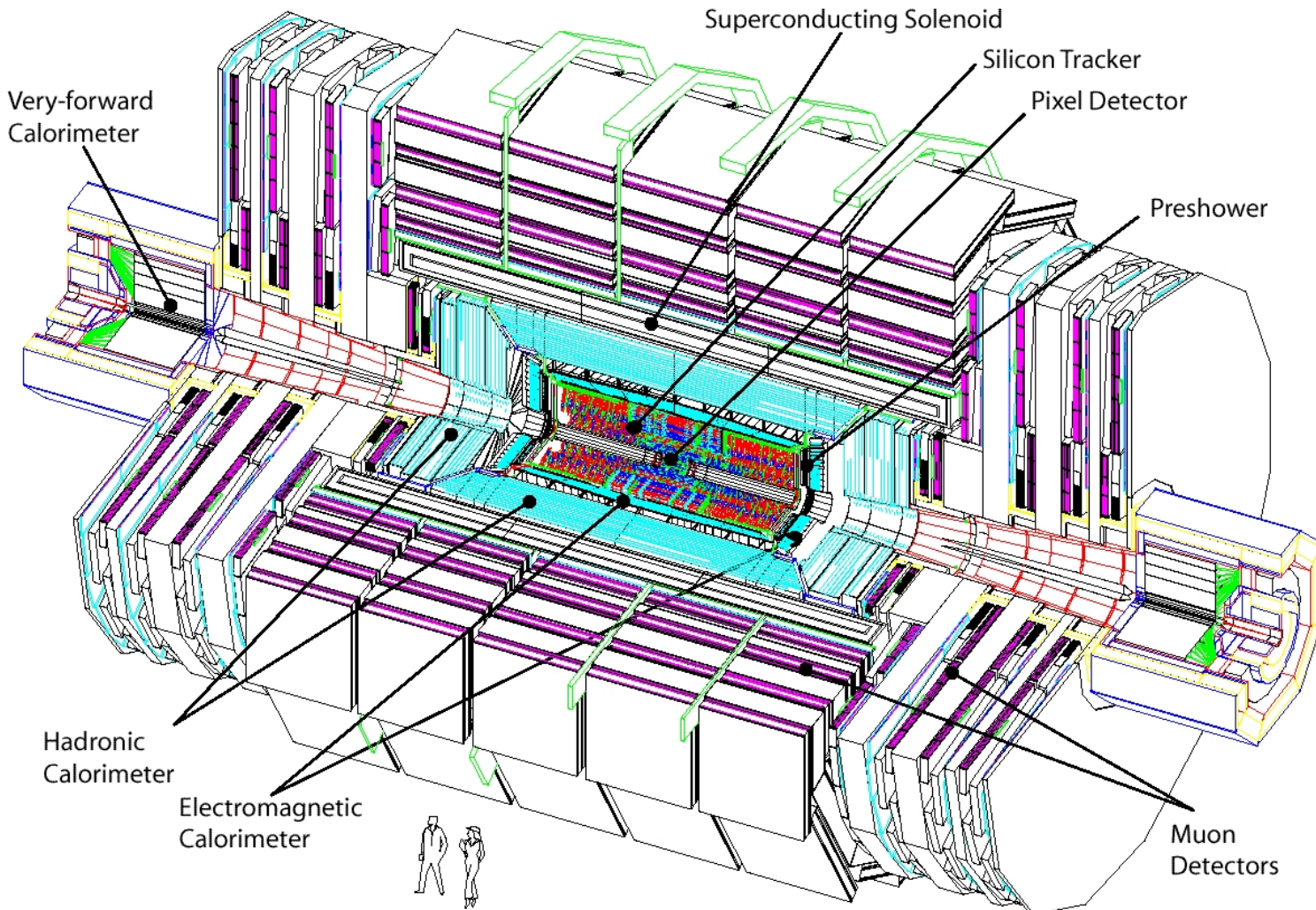
After 13 years of R&D and construction we install the Pixel Detector into CMS







# Compact Muon Solenoid



Compact Muon Solenoid

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# Some more parameters for 2D systems

- Point Spread Function (**PSF**) (Line spread function (LSF) or spatial resolution):

A very small beam (smaller than the pixel size) will produce a spot with a certain size and shape. Very important are the FWHM; and the tails of the PSF.

This is experimentally difficult → use sharp edge and LSF

Note: pixel size is not spatial resolution! (but should be close to it in an optimal design).



# Some more parameters for 2D systems

- Modulation Transfer Function (**MTF**):  
How is a spatially modulated signal (line pattern) recorded (transferred) by the detector?

$$\textit{Modulation} \equiv \textit{contrast} \equiv \frac{\textit{Max} - \textit{Min}}{\textit{Max} + \textit{Min}}$$

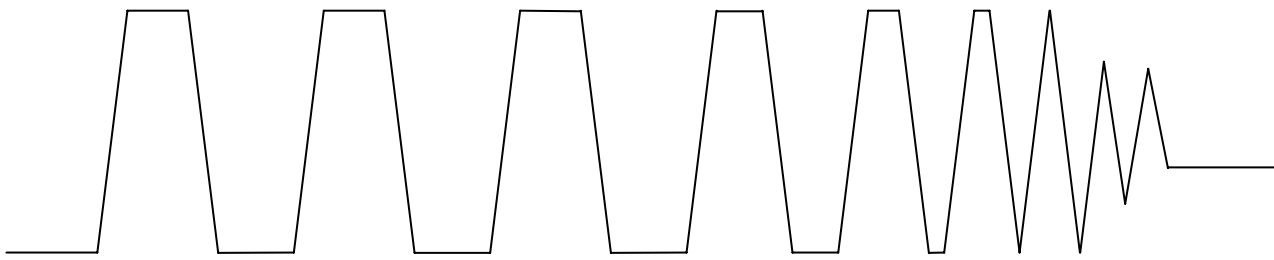
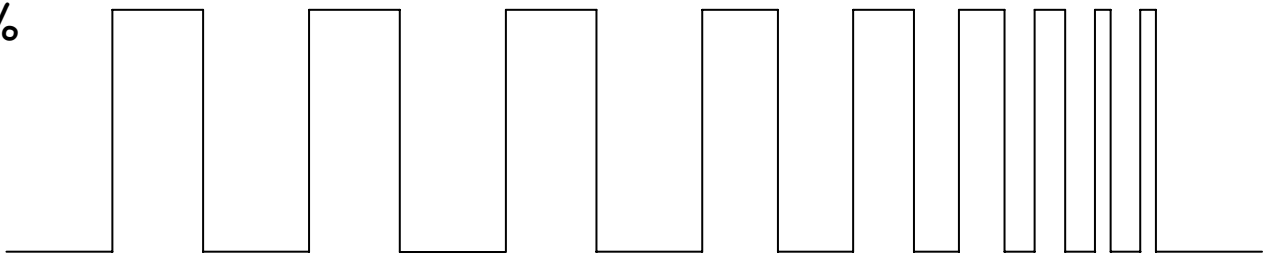
This depends on the frequency.

Is directly related to the LSF and the DQE



100 %

0 %







# Some more parameters for 2D systems

- Modulation Transfer Function (**MTF**) Example

Ideal: 
$$\textit{contrast} \equiv \frac{100 - 0}{100 + 0} = 1.0$$

Effect of noise: 
$$\textit{contrast} \equiv \frac{150 - 50}{150 + 50} = 0.5$$

Effect of PSF: 
$$\textit{contrast} \equiv \frac{75 - 25}{75 + 25} = 0.5$$



# Summary Detectors

- **Signal-to-noise** ratio most fundamental parameter in measurements.
- A detector is always a **compromise** (ex. speed vs. noise). Application determines what you compromise.
- Never take a detector as a “perfect black box”, **be aware of limitations**.
- **Understanding your detector is part of understanding your science.**